

ORDER NO. KM40304054C2

Service Manual

Telephone Equipment

KX-TCD400GC / KX-TCD400GF / KX-A140EXC / KX-A140EXF

Digital Cordless Phone

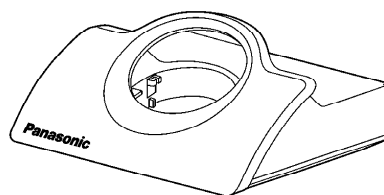
Dark Blue Version

Light Purple Version

(for Germany)



KX-A140EXC/EXF
(HANDSET)



KX-TCD400GC/GF
(BASE UNIT)

SPECIFICATIONS

SPECIFICATION

Standard:	DECT= (Digital Enhanced Cordless Telecommunications)	Battery life, Handset (if batteries are fully charged):	Stand-by: Up to 120 hours (Ni-MH) Talk: Up to 10 hours (Ni-MH)
Number of channels:	120 Duplex Channels	Operating conditions:	5 - 40 °C, 20 - 80 % relative air humidity (dry)
Frequency range:	1.88 GHz to 1.9 GHz	Dimensions, Base Unit (D x W x L):	58 mm x 128 mm x 105 mm
Duplex procedure:	TDMA (Time Division Multiple Access)	Dimensions, Handset (D x W x L):	143 mm x 48 mm x 32 mm
Channel spacing:	1728 kHz	Weight, Base Unit:	about 170 g
Bit rate spacing:	1152 kbit/s	Weight, Handset:	about 120 g
Modulation:	GFSK	Connection jack:	RJ11 to TAE-F Plug
RF Transmission Power:	approx 250 mW	AC adaptor plug:	2 Pin European
Voice coding:	ADPCM 32 kbit/s		
Operation range:	Up to 300 m outdoors, Up to 50 m indoors		
Analog telephone connection:	Telephone Line/PBX		
Power source:	AC Adaptor 220 - 240 V, 50/60 Hz		
Power consumption, Base Unit:	5 VA		

Specifications are subject to change without notice.

IMPORTANT INFORMATION ABOUT LEAD FREE, (PbF), SOLDERING

If lead free solder was used in the manufacture of this product the printed circuit boards will be marked PbF. Standard leaded, (Pb), solder can be used as usual on boards without the PbF mark. When this mark does appear please read and follow the special instructions described in this manual on the use of PbF and how it might be permissible to use Pb solder during service and repair work.

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 WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

When you note the serial number, write down all 11 digits. The serial number may be found on the bottom of the unit.

Panasonic

1. ABOUT LEAD FREE SOLDER (PbF: Pb free)

Note:

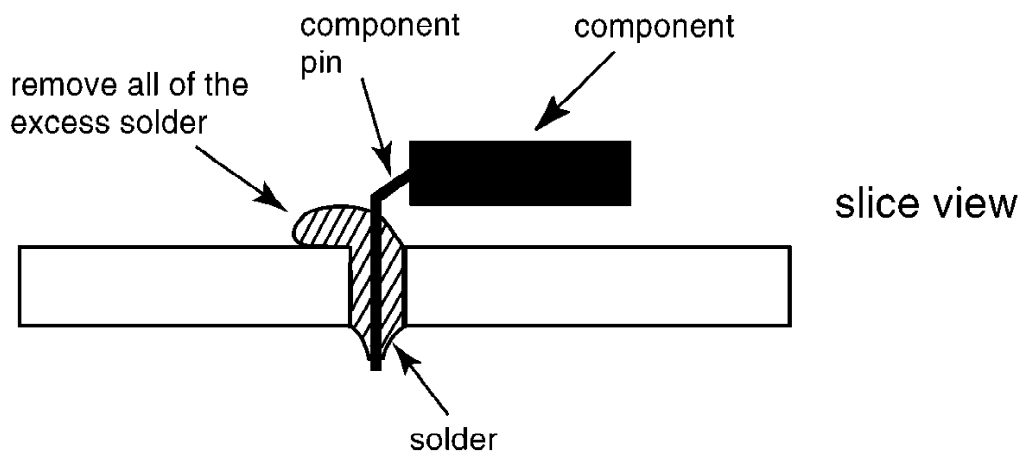
In the information below, Pb, the symbol for lead in the periodic table of elements, will refer to standard solder or solder that contains lead.

We will use PbF when discussing the lead free solder used in our manufacturing process which is made from Tin (Sn), Silver (Ag), and Copper (Cu).

This model, and others like it, manufactured using lead free solder will have PbF stamped on the PCB. For service and repair work we suggest using the same type of solder although, with some precautions, standard Pb solder can also be used.

Caution

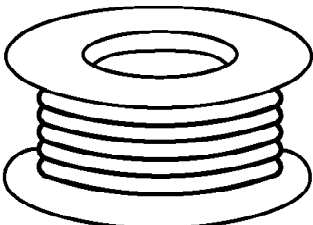
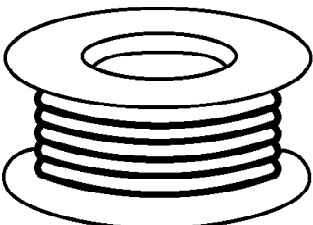
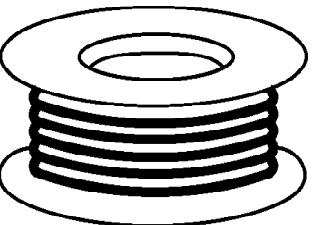
- **PbF solder has a melting point that is 50°F ~70°F (30°C ~ 40°C) higher than Pb solder. Please use a soldering iron with temperature control and adjust it to 700°F ± 20°F (370°C ± 10°C). In case of using high temperature soldering iron, please be careful not to heat too long.**
- **PbF solder will tend to splash if it is heated much higher than its melting point, approximately 1100°F (600°C).**
- **If you must use Pb solder on a PCB manufactured using PbF solder, remove as much of the original PbF solder as possible and be sure that any remaining is melted prior to applying the Pb solder.**
- **When applying PbF solder to double layered boards, please check the component side for excess which may flow onto the opposite side (See the figure below).**



1.1. Suggested PbF Solder

There are several types of PbF solder available commercially. While this product is manufactured using Tin, Silver, and Copper (Sn+Ag+Cu), you can also use Tin and Copper (Sn+Cu) or Tin, Zinc, and Bismuth (Sn+Zn+Bi). Please check the manufacturer's specific instructions for the melting points of their products and any precautions for using their product with other materials.

The following lead free (PbF) solder wire sizes are recommended for service of this product: 0.3mm, 0.6mm and 1.0mm.

0.3mm X 100g	0.6mm X 100g	1.0mm X 100g
		

1.2. How to recognize that Pb Free solder is used

1.2.1. Base Unit PCB

(Component View)
(Flow Solder Side View)

1.2.2. Handset PCB

(Component View)
(Flow Solder Side View)

2. FOR SERVICE TECHNICIANS

ICs and LSIs are vulnerable to static electricity.

When repairing, the following precautions will help prevent recurring malfunctions.

1. Cover the plastic parts boxes with aluminum foil.
2. Ground the soldering irons.
3. Use a conductive mat on the worktable.
4. Do not touch IC or LSI pins with bare fingers.

3. CAUTION

Danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer.

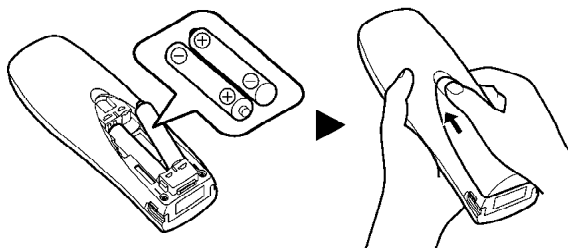
Dispose of used batteries according to the manufacture's Instructions.

4. BATTERY

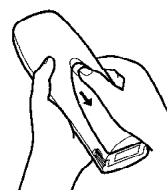
4.1. Battery Instration

Please ensure the batteries are inserted as shown.  part should be inserted first.
Close the cover as indicated by the arrow.

- When you replace the batteries,  part should be removed first.



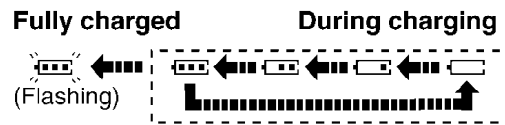
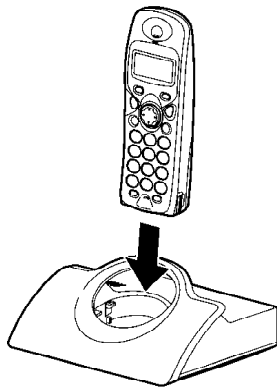
To replace the battery:
Press the notch on the cover firmly
and slide it as indicated by the arrow.
Replace 2 batteries and close the
cover then charge the handset for
about 7 hours.



4.2. Battery Charge

At the time of shipment, the batteries are not charged. To charge, place the handset on the base unit.

Please charge the batteries for about 7 hours before initial use. During charging, the battery icon is as shown below.



Display icon	Battery strength
	High
	Medium
	Low
	Needs to be charged

The handset which power is off will be turned on automatically when it is placed on the base unit.

In normal use, the handset and the base unit should be powered on at all times.

Note for Service:

The battery strength may not be indicated correctly if the battery is disconnected and connected again, even after it is fully charged.

In that case, by recharging the battery as mentioned above, you will get a correct indication of the battery strength.

4.3. Battery Life

- Battery life is dependent on use and conditions but in general when using fully charged Ni-MH batteries (700 mAh):

Talk time: 10hrs approx.

Standby time: 120hrs approx.

- When using Ni-Cd batteries (250 mAh):

Talk time: 4hrs approx.

Standby time: 40hrs approx.

(Times indicated are for peak performance)

- The batteries reach peak performance after several full charge/ discharge cycles.
- The batteries cannot be overcharged unless they are repeatedly removed and replaced.
- If battery life is shortened then please check that battery and charge terminals are clean.
- For maximum battery life, it is recommended that the handset is

not recharged until battery icon flashes



4.4. Replacing the Batteries

If the  icon flashes after a few telephone calls even when the handset batteries have been fully charged, 2 batteries must be replaced.

Charge new batteries for approximately 7 hours before initial use.

(The telephone line cord must not be connected to the telephone socket at this time).

When replacing the batteries, ensure that the correct battery type is selected.

Selecting the Battery Type

1 	2 	3 	4 
Press MENU .	Search/Select "SETTING HS".	Search/Select "OTHER OPT".	Search/Select "BATTERY TYPE".
5 	Search/Select "NI-CD" or "NI-MH".		

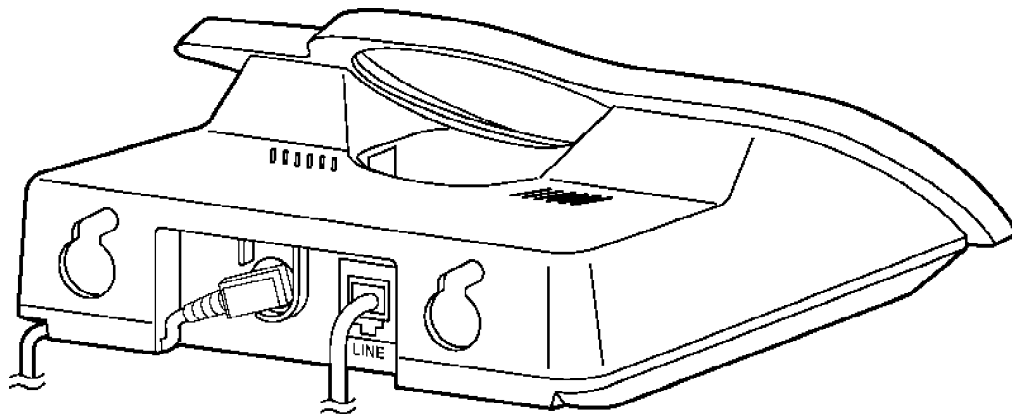
- To exit the operation, press  any time.

- When Ni-Cd batteries are fitted with the "BATTERY TYPE" setting in "NI-MH",  icon will disappear and stop charging even if the handset is on the cradle.
- Do not use non-rechargeable batteries. If non-rechargeable batteries are fitted and start charging, it may cause the leakage of the battery electrolyte.

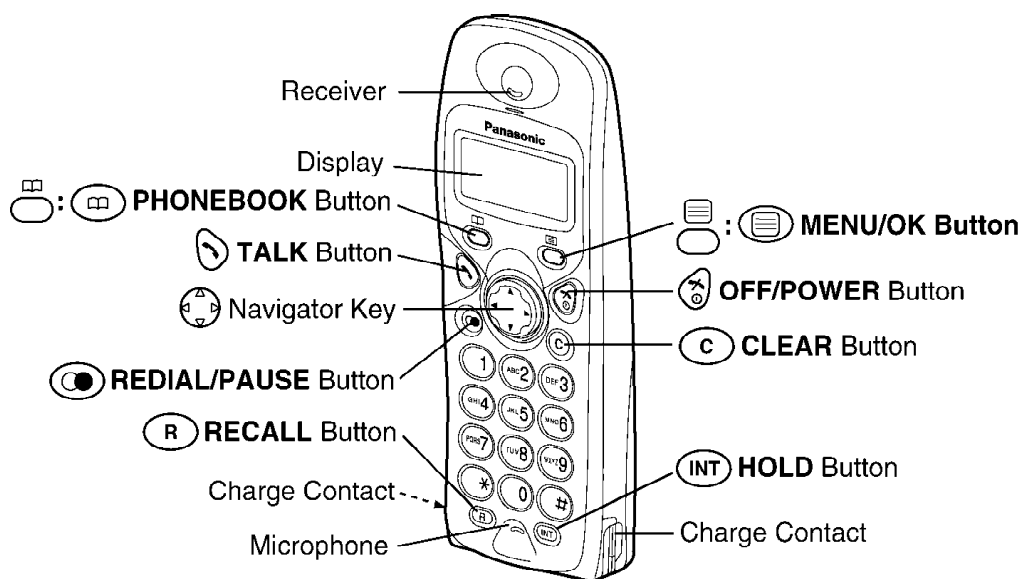
Please use only Panasonic P03P(Ni-MH) or P03H(Ni-Cd) batteries.

5. LOCATION OF CONTROLS

5.1. Base Unit



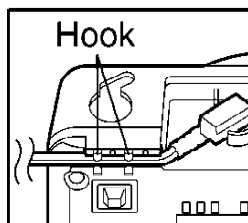
5.2. Handset



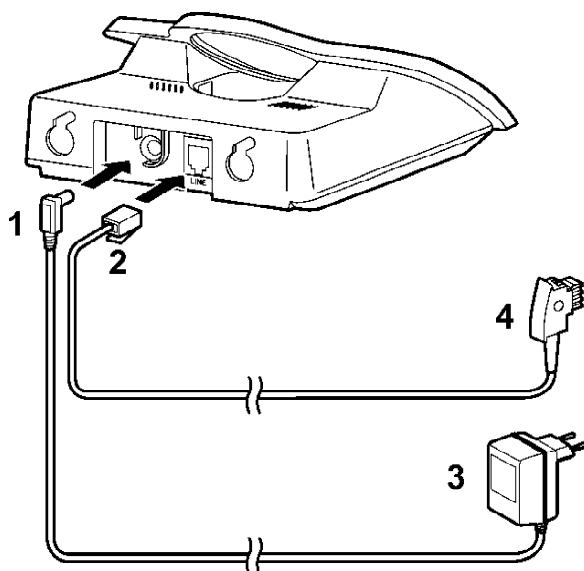
6. SETTINGS

6.1. Connection

Plug in the AC adaptor and the telephone line cord in order 1, 2, 3, 4.



Fasten the AC adaptor cord to prevent it from being disconnected.



The AC adaptor must remain connected at all times (It is normal for the adaptor to feel warm during use).

- Never install telephone wiring during a lightning storm.

6.2. Symbols Used in This Service Manual

Symbol	Meaning
	To search the desired item, press UP or DOWN .
	To select the desired item, press RIGHT .
	To search and then to select the desired item, press UP or DOWN then RIGHT .
	To move the cursor to the right or to the left, press RIGHT or LEFT .
	To go to the next step.
" "	The words in " " indicate the words in display.

6.3. PIN Code

6.3.1. Base Unit

1		2		 "INPUT CODE"
	Press MENU.		Search/Select "SETTING BS".	
3		4*	Current 4-digit Base Unit PIN	
5	New 4-digit Base Unit PIN		6 New 4-digit Base Unit PIN again to verify	

Changing Base Unit PIN

The factory preset is 0000. Once you have programmed the base unit PIN, you cannot confirm it. We recommend you write down the base unit PIN. If you forget it, please consult our customer Hotline. 0180 - 525 13 67

- To exit the operation, press  any time.

For Service Hint:



* : If the current 4-digit PIN is forgotten, press  and you will be able to enter new PIN.

6.3.2. Handset

1		2		3	
	Press MENU.		Search/Select "SETTING HS".		Search/Select "OTHER OPT".
4		5 *	Current 4-digit Handset PIN		
	Search/Select "HSPIN CHANGE".				
6	New 4-digit Handset PIN		7 New 4-digit Handset PIN again to verify		

Changing Handset PIN

The factory preset is 0000. Once you have programmed the handset PIN, you cannot confirm it. We recommend you write down the handset PIN. If you forget it, please consult our customer Hotline. 0180 - 525 13 67

- To exit the operation, press  any time.

For Service Hint:



* : If the current 4-digit PIN is forgotten, press  and you will be able to enter new PIN.

6.3.3. Reset Base Unit PIN to Default (0000) -When There is NO Handset Registered-

6.3.3.1. Symptom

There is no way to reset base PIN when there is no handset registered to the base.

6.3.3.2. Thinkable Situation

- Customer may ask to reset base PIN because they forget it.
- Customer may bring only a base unit for repair and there is no handset registered to the base (Need to register another handset to the base to confirm if the unit works properly after repair).
- When original handset has broken and customer purchased a new one, if customer forget base PIN, customer cannot register the new handset and may ask to reset the PIN.

6.3.3.3. Remedy

<Preparation>

Refer to [JIGs and PC](#) ().

<Connection>

1. Solder a pin or lead wire to GND, SDA, and SCLK on base PCB.
2. Plug in AC adaptor to the base.
3. Turn on the power to the JIG (9V).
4. Then connect the cable to each pins using clip.

As for the connection between JIG and PCB, see below photos.

<PC setting and how to reset base PIN to default (0000)>

1. Refer to [PC Setting](#) ().
2. Next, execute <initbspin.bat> by typing "initbspin". The PC display will be shown as below.
3. After that, turn off DC power supply (9V) to the jig, unplug AC adaptor, and remove pins on PCB.
Then close the cabinet. The base pin returns to the default (0000) and you can register a handset to the base using the base PIN (0000).

6.4. Reset

6.4.1. Base Unit

1 	2 	 "INPUT CODE"	3 
Press MENU .	Search/Select "SETTING BS".		
4 4-digit Base Unit PIN*1	5 		
	Press OK .		

- To exit the operation, press  any time.
- *1: The factory preset is 0000.

Base Unit Initial Settings

Function	Initial Setting
Flash/Earth	Flash
Flash Timing	200 msec
Pause Timing	3 seconds
4-Digit Base Unit PIN	0000
ARS Setting	OFF
Carrier Code	All Clear
Area Code	All Clear
Relation of Area Code	All Area Code to Carrier Code 1

6.4.2. Handset

You can reset all of the handset settings to their initial settings.

1 	2 	3 	4 4-digit Handset PIN*1
Press MENU .	Search/Select "SETTING HS".	Search/Select "RESET HS".	
5 	Search/Select "YES" or "NO".		

- To exit the operation, press  any time.
- *1: The factory preset is 0000.

Handset Initial Settings

Function	Initial Setting
Time Alarm Mode	OFF
Alarm Time	Clear
Handset Ringer Volume	6
Handset External Ringer Pattern	1
Handset Alarm Tone Pattern	1
Key Tone	ON
Range Warning Alarm	OFF
Battery Low Alarm	ON
Talk Mode Display	Length of the Call
Display Language	German
Call BAR	OFF
Direct Call Mode	OFF
Direct Call Number	Clear
4-Digit Handset PIN	0000
Auto Talk	OFF
Redial Memory	All Clear
Handset Receiver Volume	Medium

6.5. Key Lock

You can lock the handset dialling buttons. Only incoming calls are accepted while the key lock is on. The key lock is cancelled if the handset is turned off.

When the key lock is on, emergency calls cannot be made until key lock is cancelled.

Key Lock On



Press **OK** for more than 2 seconds.

Key Lock Off



Press **OK** for more than 2 seconds.

 is displayed and all dialling buttons are locked.

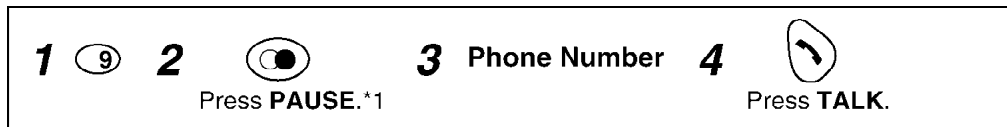
6.6. Recall Feature

RECALL is used to access special telephone services. Contact your Network provider for details. If your unit is connected to a PBX, pressing RECALL allows you to access some features of your host PBX such as transferring an extension call.

6.7. Dialling Pause for PBX line/long distance service users

A dialling pause is used when a pause in the dialling of the phone number is necessary using a PBX or accessing a long distance service.

For example, when 9 (line access number) is dialled followed by a pause to access an outside line through a PBX:



- Entering a pause prevents misdialling when you redial or dial a stored number.
- Pressing **PAUSE** once creates one pause. To extend the pause requirement time, press **PAUSE** accordingly.

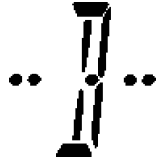
^{*1}  is displayed on the LCD.

6.8. Call BAR On/Off

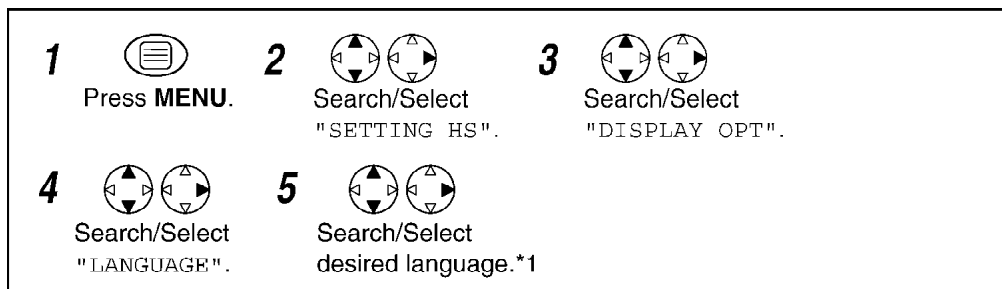
This allows you to make emergency call.



- To exit the operation, press  any time.
- ^{*1}: The factory preset is 0000.

- ^{*2}: If "ON" is selected,  is displayed.

6.9. Selecting the Display Language



- To exit the operation, press any time.
- *1 You can select one of 10 languages. If you set a language you cannot read, reset the handset to its initial settings.
Press **MENU** → **DOWN** → **RIGHT** → **UP** → **RIGHT** → 4-digit Handset PIN → **UP** → **OK**
All handset setting will be reset to their initial settings, however, the Phonebook data will be saved.

6.10. Summary of Programmable Functions

You can select and execute the following functions by pressing direct command as follows without programming.

These operations need to be done with the Handset near the base unit.

Press . Press or until the arrow points to
"Setting Base", then press .
"Input Command" is displayed.*1

<Direct command>

♦ 4-digit Base Unit PIN ♦	Pause Timing
	Changing Base Unit PIN
	Cancelling a Handset
♦ 4-digit Base Unit PIN ♦	Automatic Route Selection
	Reset Base Unit Settings
	Setting the Clock
	Setting the Date

*1 If any key is not pressed over 60 seconds, the display will return to "Setting Base".

*2 Refer to **PIN Code ()** for more details.

7. DISPLAY

7.1. Handset Display

Icon	Displays	Icon	Displays
	Within range of a base unit		Call Bar ON
	Out of range/ No power on base unit		Direct Call ON
	Using the handset		Key Lock ON
	Making or answering calls		Ringer Volume OFF
	Phonebook Mode		Dialling Pause
	In Setting Mode		
	Battery strength is low		
	Battery strength is high		

7.2. Before Requesting Help (Troubleshooting)

If you experience any problems with the normal use of your apparatus, you should unplug it from the telephone outlet and connect a known working telephone in its place.

If the known working telephone still has problems, then please contact the customer service department of your Network provider.

If it operates correctly, then the problem is likely to be a fault in your apparatus.

In this case, contact your supplier for advice. Your Network provider may charge you if they attend a service call that is not due to apparatus supplied by them.

Turn the power OFF then ON (Handset) / Disconnect then connect the AC adaptor (Base Unit).

Problem	Possible cause	Solution
NO LCD display in handset.	• Handset not turned on.	• Turn on power. →(Refer to Power On/Off .)
Handset will not turn on.	• Batteries not inserted. • Batteries not charged.	• Insert the 2 rechargeable batteries supplied . • Place handset in base and connect AC adaptor to base and AC outlet (full charge period 7 hrs).
Batteries charge icon not counting up.	• Dirty charge contact. • Base not powered up.	• Clean charge / battery contact and retry charge. • Connect AC adaptor to base unit and AC outlet.
📶 icon flashes.	• Handset out of range of base. • No power into base unit.	• Move handset closer to base. • Connect AC adaptor to base unit and AC outlet.
Handset busy tone heard when 📞 is pressed.	• Handset out of range of base.	• Move handset closer to base.
No dial tone.	• Telephone line not connected.	• Insert telephone cord to network. • Turn power OFF then ON.
Cannot dial out.	• Call BAR set. Particular dialled number is restricted. • Key lock mode ON.	• Turn feature off. →(Refer to Call BAR On/Off .) • Turn key lock OFF. →(Refer to Key Lock .)
Handset will not ring.	• Ringer switched off.	• Set ringer to one of 6 volume levels.
Last number redial does not work.	• Number exceeded 24 digits.	• Redial manually.
🔋 icon flashes.	• Battery low.	• Recharge batteries.
🔋 icon is disappeared.	• Wrong battery type selected.	• Set the correct battery type.

Cross Reference:

Power On/Off ()

Call BAR On/Off ()

Key Lock ()

8. OPERATIONS

8.1. Power On/Off

Power on



Press for more than 1 second. *1

Power off



Press for more than 2 seconds. *2



*1 When button is released, the display changes to the standby mode.

*2 The display goes blank.

8.2. Making a Call

Pre-dialling

1 Phone Number *1

2



Press TALK.

Post-dialling



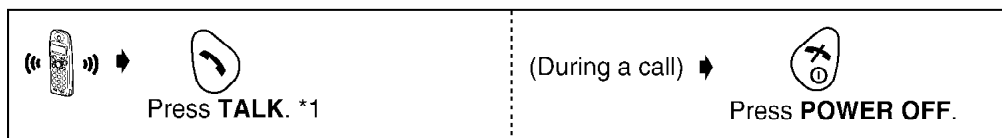
Press TALK.

2 Phone Number

*1 If you need correction, press CLEAR. Digit is cleared to the left, then enter numbers.

8.3. Answering Calls

Terminating a Call

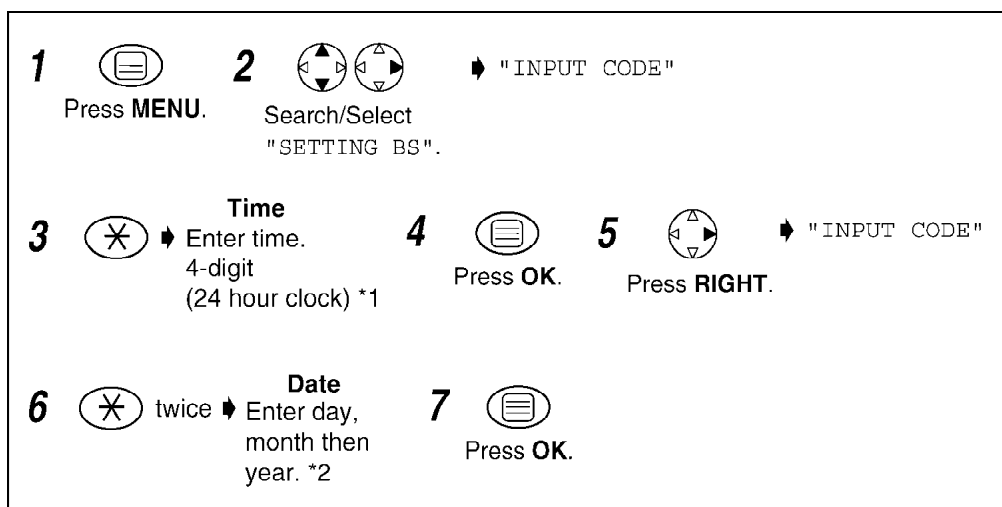


- Each ringer will start ringing with lower volume then gradually increase the volume when receiving a call.

*1 You can also answer a call by pressing any dialling button, HOLD, #, or *.

8.4. Setting the Clock/Date

After a mains power failure the clock needs to be reset. Ensure that  icon is not flashing.



- To exit the operation, press  any time.

*1 For example, to set 7:15, enter 0715.

*2 For example, to set the 16th of February, 2003, enter 160203.

8.5. Phonebook

You can store up to 20 caller information in the phonebook.

8.5.1. Storing a Caller Information

1 	2 	3 Phone Number	4 
Press MENU .	Select "NEW PHONE".	Enter phone number. (max. 24 characters) *1	Press OK .
5 Name	6 		
Enter name. (max. 9 characters)*1	Press OK . *2		

- To exit the operation, press  any time.

*1 If you need correction, press RIGHT or LEFT to move cursor then clear a character by pressing CLEAR, and/or enter characters. Characters are cleared or added to the left of the flashing character. To enter characters, see Character Selection below.

*2 To continue storing another caller information, repeat the steps from 3.

Character Selection

Keys	Number of times key is pressed								Keys	Number of times key is pressed				
	1	2	3	4	5	6	7	8		1	2	3	4	5
	#	[	]	*	,	-	/	1		M	N	O	6	
	A	B	C	2						P	Q	R	S	7
	D	E	F	3						T	U	V	8	
	G	H	I	4						W	X	Y	Z	9
	J	K	L	5						Blank	0			

Character Table

A	B	C	D	E	F	G	H	I	J	K	L	M	N	O	P	Q	R	S	T	U	V	W	X	Y
a	b	c	d	e	f	g	h	i	j	k	l	m	n	o	p	q	r	s	t	u	v	w	x	y
Z	1	2	3	4	5	6	7	8	9	*	0	#	-	/	[	]	,							
z	1	2	3	4	5	6	7	8	9	*	0	#	-	/	[	]	,							

Editing a Caller Information

1 	2 	3 	4 The 1st digit of the desired phone number blinks.
Press PHONEBOOK . ^{*1}	Search/Select desired item.	Select "EDIT".	
<Phone Number>			
5 	6 	AND/OR	7 
Move cursor.	Press CLEAR . ^{*2}	Number	Press OK .
		Edit the phone number. ^{*3}	
<Name>			
8 	9 	AND/OR	10 
Move cursor.	Press CLEAR . ^{*2}	Name	Press OK .
		Edit the name. ^{*4}	

Clearing a Caller Information

1 			4 
Press PHONEBOOK . ^{*1}	Search/Select desired item.	Search/Select "CLEAR".	Search/Select "YES". ^{*5}

Dialling with the Phonebook

1 	2 	3 
Press PHONEBOOK . ^{*1}	Search desired item.	Press TALK .

- To exit the operation, press  any time.

*1 If there is no item stored in the phonebook, the display shows "NO ITEM".

*2 Digits are cleared to the left of the flashing digit.

*3 Digits are added to the left of the flashing digit. If you need to clear or add more than one digit, repeat the steps from 5.

*4 Characters are added to the left of the flashing character. If you need to clear or add more than one character, repeat the steps from 2.

*5 To continue clearing another caller information, repeat the steps from 2.

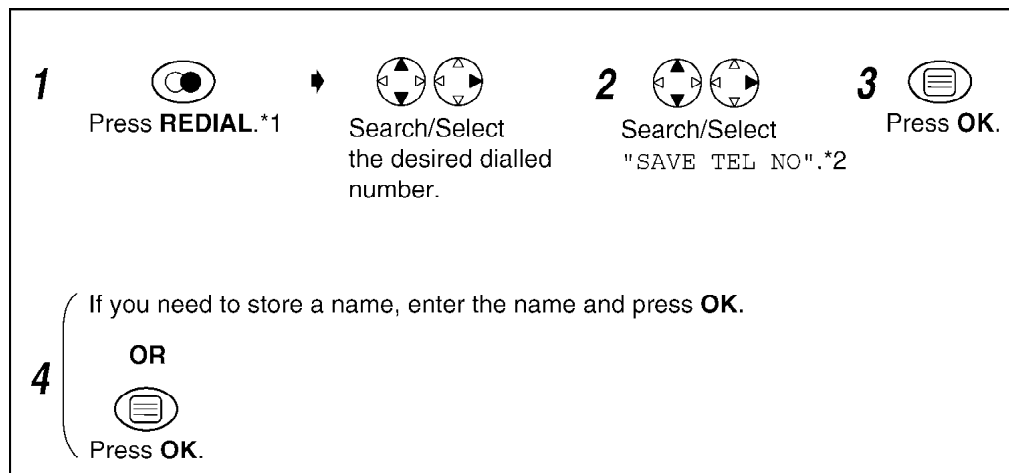
8.5.2. Storing the Phone Number into the Phonebook When Pre-dialling

1 Phone Number ^{*1}	2 	3 	4 Name
	Press OK to store the number.	Press OK twice.	Enter name.
5 	Press OK .		

- To exit the operation, press  any time.

*1 If you need correction, press CLEAR. Digit is cleared to the left, then enter numbers.

8.5.3. Storing the Number from the Redial List into the Phonebook



- To exit the operation, press  any time.

*1 If there is no item stored in the redial/caller list, the display shows "NO ITEM".

*2 If you need correction, press RIGHT or LEFT to move cursor then clear a character by pressing CLEAR, and/or enter digits. Digits are cleared or added to the left of the flashing digit.

8.5.4. Hot Key (: Speed Dial)

You can assign the dialling buttons 1 through 9 as hot keys. You can choose 9 phone numbers from the phonebook.

Registering a Phone Number as a Hot Key

1  Press PHONEBOOK.*1	2  Search/Select desired item.	3  Search/Select "HOT KEY REG".	4  Search/Select desired dialling button number.*2
5  Search/Select "YES".			

Dialling with Hot Key

1 Press and hold the dialling button registered as a hot key.	2  Press TALK .
--	---

Clearing the Hot Key Registration

1 Press and hold the dialling button registered as a hot key.	2  Press RIGHT .	3  Select " CLEAR ".	4  Search/Select "YES".*3
--	--	---	---

- To exit the operation, press  any time.

*1 If there is no item stored in the phonebook, the display shows "NO ITEM".

*2 The number is flashing if the dialling button is already assigned as a hot key.

*3 Phonebook registration will be remained even hot key registration is cleared.

9. DISASSEMBLY INSTRUCTIONS

9.1. Base Unit

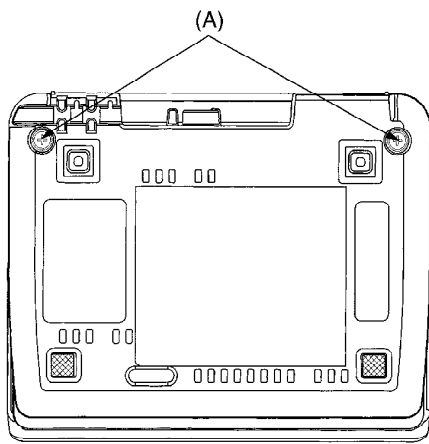


Fig. 1

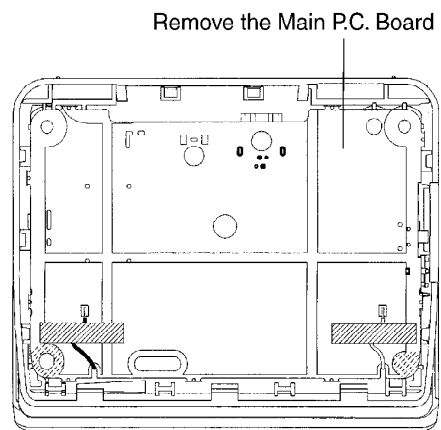


Fig. 2

Shown in Fig.-	To Remove	Remove
1	Lower Cabinet	Screws (2.6 × 12).....(A) × 2
2	Main P.C. Board	Main P.C. Board

9.2. Handset

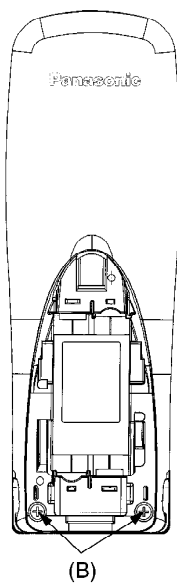


Fig. 3

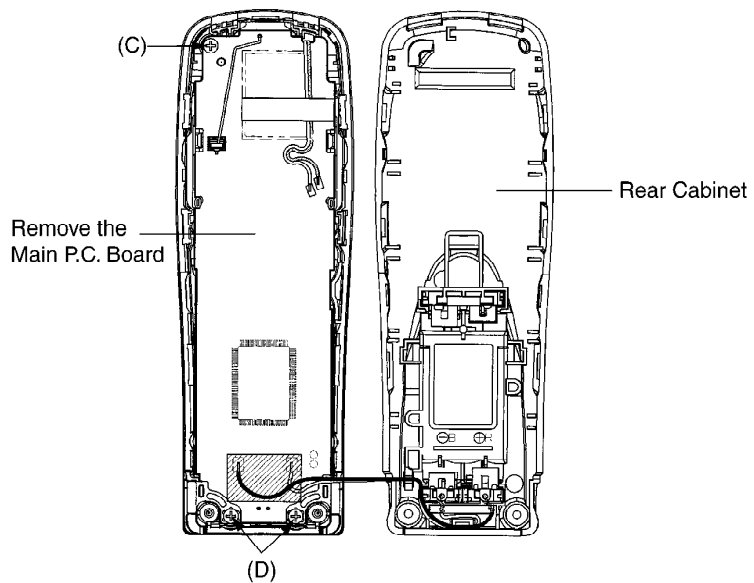


Fig. 4

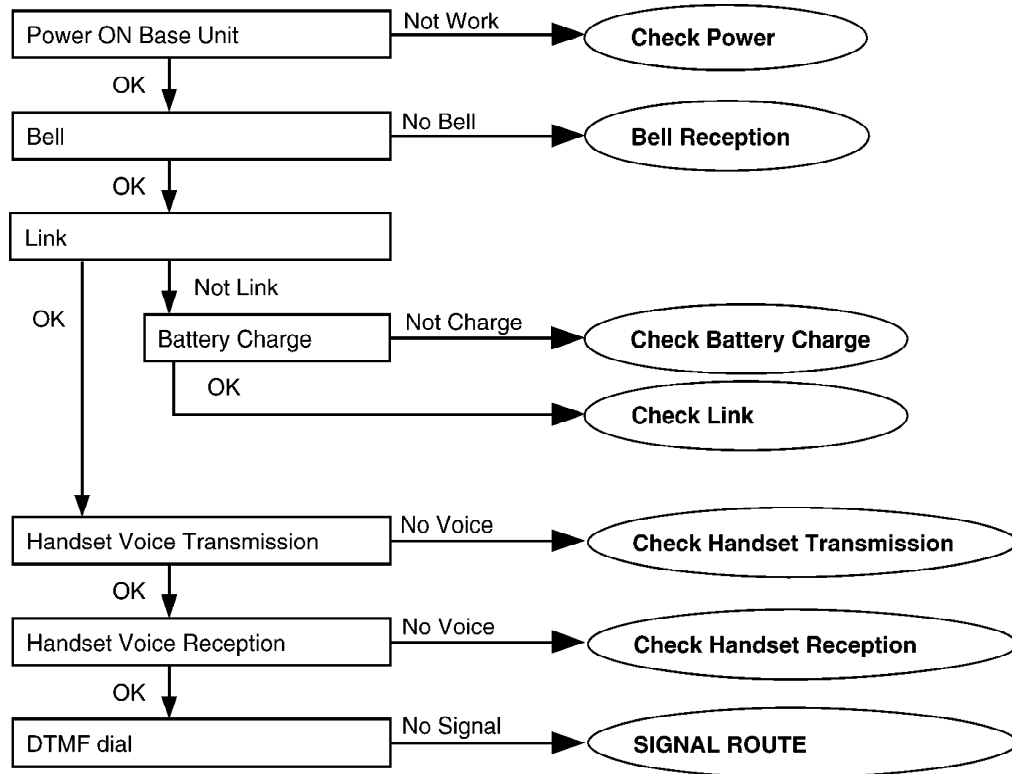
Shown in Fig.-	To Remove	Remove
3	Rear Cabinet	Screws (2 × 10).....(B) × 2
4	Main P.C. Board	Screw (2 × 8).....(C) × 1
4	Main P.C. Board	Screws (2 × 8).....(D) × 2
		Main P.C. Board

10. ASSEMBLY INSTRUCTIONS

10.1. Warning When Constructing the Base Unit

11. TROUBLESHOOTING GUIDE

Flow Chart



Cross Reference:

[Check Power \(\)](#)

[Bell Reception \(\)](#)

[Check Battery Charge \(\)](#)

[Check Link \(\)](#)

[Check Handset Transmission \(\)](#)

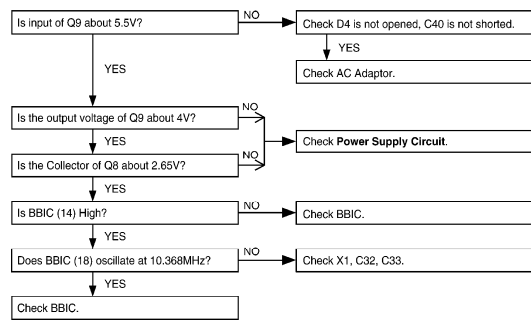
[Check Handset Reception \(\)](#)

[SIGNAL ROUTE \(\)](#)

11.1. Check Power

11.1.1. Base Unit

Is the AC Adaptor inserted into AC outlet? (Check AC Adaptor's specification.)



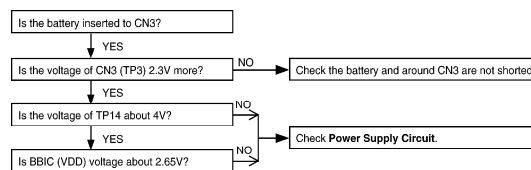
Cross Reference

Power Supply Circuit ()

Note:

BBIC is IC2.

11.1.2. Handset



Cross Reference

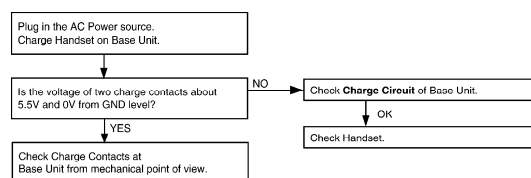
Power Supply Circuit/Reset Circuit ()

Note:

BBIC is IC1.

11.2. Check Battery Charge

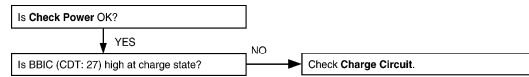
11.2.1. Base Unit



Cross Reference:

Charge Circuit ()

11.2.2. Handset



Cross Reference:

[Check Power \(\)](#)

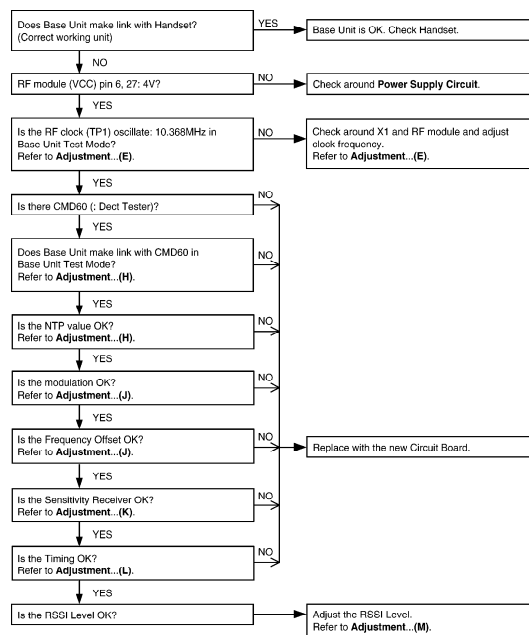
[Charge Circuit \(\)](#)

Note:

BBIC is IC1.

11.3. Check Link

11.3.1. Base Unit

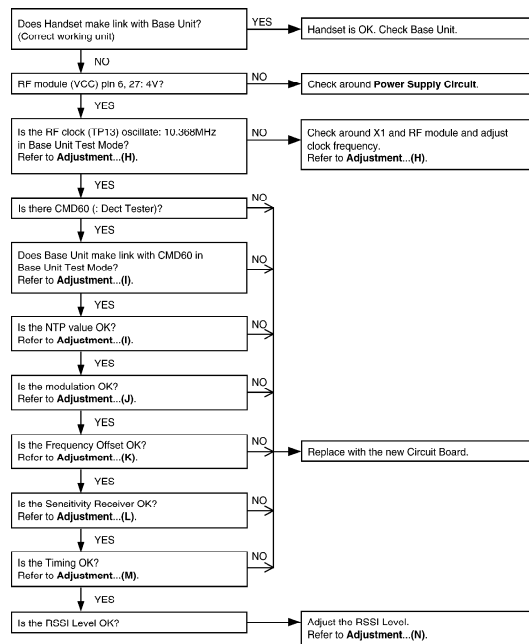


Cross Reference:

[Power Supply Circuit \(\)](#)

[Adjustment \(\)](#)

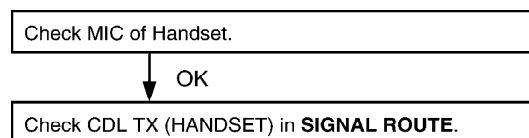
11.3.2. Handset



Cross Reference

Power Supply Circuit ()
Adjustment ()

11.4. Check Handset Transmission



Cross Reference:
SIGNAL ROUTE ()

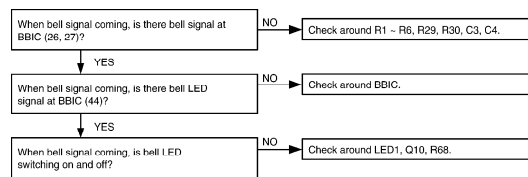
11.5. Check Handset Reception



Cross Reference:
HOW TO CHECK THE HANDSET SPEAKER ().
SIGNAL ROUTE ()

11.6. Bell Reception

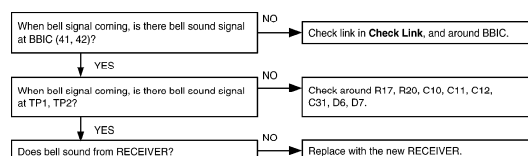
11.6.1. Base Unit



Note:

BBIC is IC2.

11.6.2. Handset



Cross Reference:

[Telephone Line Interface](#) ()

[Check Link](#) ()

Note:

BBIC is IC1.

12. CHECK PROCEDURE (BASE UNIT)

12.1. Preparation

12.1.1. Equipment Required

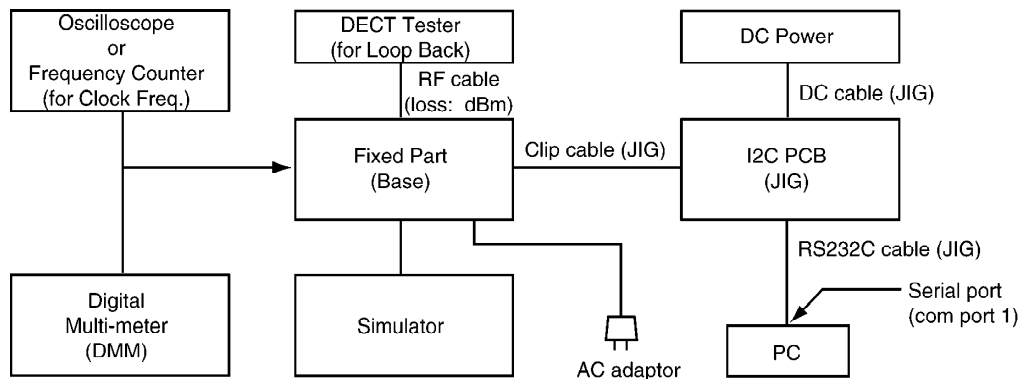
- DECT tester: Rohde & Schwarz, CMD 60 is recommended.
- Frequency counter: it must be precise to be able to measure 1Hz (precision; $\pm 4\text{ppm}$).
Hewlett Packard, 53131A is recommended.
- DC power: it must be able to output at least 1A current under 9V.
- Digital multi-meter (DMM): it must be able to measure voltage and current.
- Oscilloscope

12.1.2. JIGs and PC

- EEPROM serial JIGs
 1. I2C PCB: PQZZTCD705BX
 2. RS232C cable: PQZZ1CD705BX
 3. Clip cable: PQZZ2CD705BX
 4. DC cable: PQZZ3CD705BX
- PC which runs in DOS mode
- Batch file for setting: PQZZTCD410E

12.2. PC Setting

12.2.1. Connections



12.2.2. PC Setting

1. Open a window of MS-DOS mode from the start-up menu.
2. Change a directory to the one with “RTX_COM” contained.
3. Type “SET RTX_COM=1” from the keyboard (when COM port 1 is used for the connection).
4. Type “doskey”.

Note:

See the table below for frequently used commands.

Command name	Function	Example
rdeeprom	Read the data of EEPROM	Type "rdeeprom 00 00 FF", and the data from address "00 00" to "FF" is read out.
readid	Read ID (RFPI)	Type "readid", and the registered ID is read out.
writeid	Write ID (RFPI)	Type "writeid 00 18 E0 0E 98", and the ID "0018 E0 0E 98" is written.
setfreq	adjust Frequency of RFIC	Type "setfreq nn nn".
hookoff	off-hook mode on Base	Type "hookoff".
hookon	on-hook mode on Base	Type "hookon".
Getchk	Read checksum	Type "getchk".
Wreeprom	write eeprom	Type "wreeprom 01 23 45". "01 23" is address and "45" is data to be written.

13. CHECK PROCEDURE (HANDSET)

13.1. Preparation

13.1.1. Equipment Required

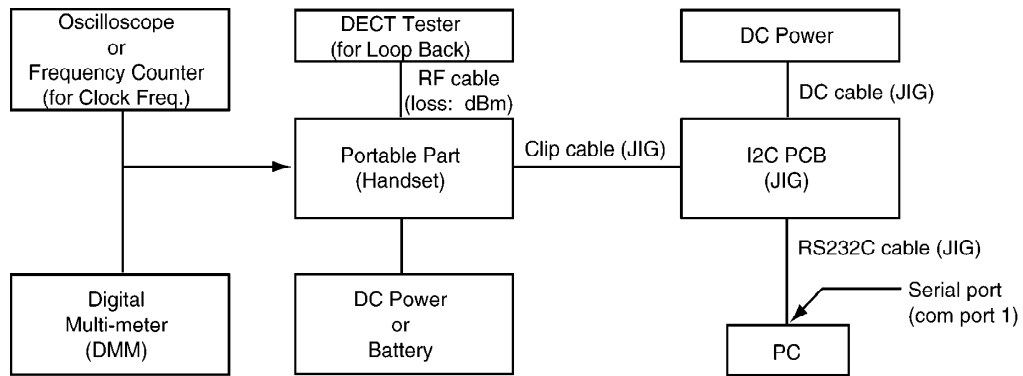
- DECT tester: Rohde & Schwarz, CMD 60 is recommended.
- Frequency counter: it must be precise to be able to measure 1Hz (precision; ± 4 ppm).
Hewlett Packard, 53131A is recommended.
- DC power: it must be able to output at least 1A current under 2.4V for Handset, 9V for JIG.
- Digital multi-meter (DMM): it must be able to measure voltage and current.
- Oscilloscope

13.1.2. JIGs and PC

- EEPROM serial JIGs
 1. I2C PCB: PQZZTCD705BX
 2. RS232C cable: PQZZ1CD705BX
 3. Clip cable: PQZZ2CD705BX
 4. DC cable: PQZZ3CD705BX
- PC which runs in DOS mode.
- Batch file for PC setting: PQZZTCD410E

13.2. PC Setting

13.2.1. Connections



13.2.2. PC Setting

1. Open a window of MS-DOS mode from the start-up menu.
2. Change a directory to the one with “RTX_COM” contained.
3. Type “SET RTX_COM=1” from the keyboard (when COM port 1 is used for the connection).
4. Type “doskey”.

Note:

See the table below for frequently used commands.

Command name	Function	Example
rdeeprom	Read the data of EEPROM	Type “rdeeprom 00 00 FF”, and the data from address “00 00” to “FF” is read out.
readid	Read ID (RFPI)	Type “readid”, and the registered ID is read out.
writeid	Write ID (RFPI)	Type “writeid 00 18 E0 0E 98”, and the ID “0018 E0 0E 98” is written.
setfreq	adjust Frequency of RFIC	Type “setfreq nn nn”.
Getchk	Read checksum	Type “getchk”.
Wreeprom	write eeprom	Type "wreeprom 01 23 45". "01 23" is address and "45" is data to be written.

14. ADJUSTMENTS (BASE UNIT)

If your unit have below symptoms, adjust or confirm each item using remedy column from the table.

Symptom	Remedy
The base unit does not respond to a call from handset.	Make adjustments in item (I)~(M)
The base unit does not transmit or the transmit frequency is off.	Make adjustments in item (H)~(J), (L)
The transmit frequency is off.	Make confirmation in item (H)~(J), (L)
The transmit power output is low, and the operating distance between base unit and handset is less than normal.	Make confirmation in item
The reception sensitivity of base unit is low with noise.	Make confirmation in item
The transmit level is high or low.	Make adjustments in item
The reception level is high or low.	Make adjustments in item
The unit does not link.	Make confirmation in item

* : Refer to [Adjustment](#) ()

14.1. Adjustment

	Items	Adjustment Point	Procedure*	
(A)	2.65V Supply Confirmation	-	1. Confirm that the voltage between TP187 and GND is $2.65V \pm 0.2V$.	IC C C R R C
(B)	4.0V Supply Confirmation	-	1. Confirm that the voltage between TP91 and GND is $4.0V \pm 0.2V$.	C R D C

	Items	Adjustment Point	Procedure*								
(C)	VBACK Status Confirmation	-	1. Confirm that the voltage between J102 and GND is 0V ± 0.4V.								
(D) *	BBIC Selftest	-	1. BBIC Selftest (Execute the command "getchk"). 2. Confirm the returned checksum value. Connection of checksum value and program number is shown below. <table><tr><th>checksum value</th><th>program number</th></tr><tr><td>A888</td><td>D231AA</td></tr><tr><td>9302</td><td>D231ZA</td></tr><tr><td>1F54</td><td>D231ZB</td></tr></table>	checksum value	program number	A888	D231AA	9302	D231ZA	1F54	D231ZB
checksum value	program number										
A888	D231AA										
9302	D231ZA										
1F54	D231ZB										
(E) *	BBIC Clock Adjustment	TP1	1. Execute the command "deactmac". 2. Execute the command "contx". 3. Input Command "rdeeprom_00_00_02", then you can confirm the current value. 4. Adjust the frequency of TP1 executing the command "setfreq 00 xx (where xx is the value)" so that the reading of the frequency counter is 10.368000MHz ± 3Hz.								
(F) *	Hookswitch Check with DC Characteristics	-	1. Connect J1 (Telephone Socket) to Tel-simulator which is connected with 600 Ω. 2. Set line voltage to 48V at on hook condition and line current to 40mA. 3. Execute the command "hookoff" 4. Confirm that the line current is 40mA ± 5mA. 5. Execute the command "hookon". 6. Confirm that the line current is 0mA + 2mA.								

	Items	Adjustment Point	Procedure*	
(G) *	DTMF Generator Confirmation	-	1. Connect J1 (Telephone Socket) to DTMF tester. 2. Execute the command "hookoff" and "dtmf_up". 3. Confirm that the high frequency group is -6.5dBm ~ -9.5dBm. 4. Execute the command "dtmf_lo". 5. Confirm that the low frequency group is -9.0dBm ~ -12.0dBm.	IC R: C R: C C F F
(H) *	Transmitted Power Confirmation	-	Remove the Antenna before starting step from 1 to 4. 1. Configure the DECT tester (CMD60) as follows; <Setting> -Testmode: FP -Traffic Channel: 5 -Traffic Slot: 4 -Mode: Loopback -PMID: 0000 2. Execute the command "testmode". 3. Initiate connection from DECT tester. 4. Confirm that the NTP value at ANT is 20dBm ~ 25dBm.	I C: C: C: C D/ C: R:

	Items	Adjustment Point	Procedure*	
(I)	Modulatoin Check and Adjustment	ANT	Follow steps 1 to 3 of (H) above. 1. Confirm that the B-Field Modulation is 340kHz/div ~ 402kHz/div using data type Fig31. 2. Adjust the B-Field Modulation if required. (Execute the command "readmod" and "wrtmod xx", where xx is the value.)	I C/ C/ C/ C D/ C/ R/
(J)	Frequency Offset Confirmation	-	Follow steps 1 to 3 of (H) above. 1. Confirm that the frequency offset is $< \pm 40\text{kHz}$.	I C/ C/ C/ C D/ C/ R/

	Items	Adjustment Point	Procedure*	
(K)	Sensitivity Receiver Confirmation	-	Follow steps 1 to 3 of (H) above. 1. Set DECT tester power to -88dBm. 2. Confirm that the BER is < 1000ppm.	I C/ C/ C/ C D/ C/ R/
(L)	Timing Confirmation	-	Follow steps 1 to 3 of (H) above. 1. Confirm that the Timing accuracy is < ± 5.0ppm.	I C/ C/ C/ C D/ C/ R/

	Items	Adjustment Point	Procedure*	
(M) *	RSSI Level Confirmation	-	Follow steps 1 to 3 of (H) above. 1. Set DECT tester power to -88dBm. 2. Execute the command "readrssi". 3. Confirm that the returned value is 0x34 ± A (hex).	I C/ C/ C/ C D/ C/ R/

	Items	Adjustment Point	Procedure*
(N) *	Receive Audio Check and Adjustment	ANT J1	1. Configure the DECT tester (CMD60) as follows; <Setting> -Testmode: FP -Mode: Normal -PMID: 0000 2. Execute the command "testmode". 3. Initiate connection from DECT tester. 4. Execute the command "hookoff". 5. Execute the command "openau". 6. Connect J1 (Telephone Socket) to Tel-simulator which is connected with 600 Ω. 7. Set line voltage to 48V and line current to 40mA. 8. Connect DECT tester to Tel-simulator. 9. Input audio signal (200mVrms/1kHz tone) to Tel-simulator. <DECT tester setting> -Scramble: On -AF Gen to ADPCM: Off -AF Meter Input: ADPCM -AF Gen Frequency: 1000Hz -AF Gen Level: 200mVrms 10. Confirm hearing tone: 360mVrms $\pm$ 60mVrms 11. Adjust audio level if required. (Make sure current value using "getmicgain". And then execute the command "setmicgain xx", where xx is the value.) 12. Confirm that the B-field audio distortion with DECT tester is < 5 %.

	Items	Adjustment Point	Procedure*	
(O) *	Transmit Audio Check and Adjustment	ANT J1	1. Configure the DECT tester (CMD60) as follows; <Setting> -Testmode: FP -Mode: Normal -PMID: 0000 2. Execute the command "testmode". 3. Initiate connection from DECT tester. 4. Execute the command "hookoff". 5. Execute the command "openau". 6. Connect J1 (Telephone Socket) to Tel-simulator which is connected with 600 Ω. 7. Set line voltage to 48V and line current to 40mA. 8. Input audio signal (30mVrms/1kHz tone) to from DECT tester. <DECT tester setting> -Scramble: On -AF Gen to ADPCM: On -AF Meter Input: AF Voltm -AF Gen Frequency: 1000Hz -AF Gen Level: 30mVrms 9. Confirm hearing tone: 700mV $\pm$ 150mV. 10. Adjust audio level if required. (Make sure current value using "getspkrgain". And then execute the command "setspkrgain xx", where xx is the value.) 11. Confirm that the audio distortion at 600R of Tel-simulator is < 5 %.	IC R: C: Q R C R C F II C: C: C: C R: C: C:
(P)	Charging Check	-	1. Connect Charge Contact 12 Ω /2W register between charge+ and charge-. 2. Measure and confirm voltage across the regigster is 2.3V $\pm$ 0.2V.	D

Note:

After the measuring, sock up the solder of TP.

* : **PC Setting** () is required beforehand.

The connection of adjustment equipment are as shown in **Adjustment Standard (Base Unit)** ().

14.2. Adjustment Standard (Base Unit)

When connecting the Simulator Equipments for checking, please refer to below.

14.2.1. Component View

Note:

(H) - (O) is referred to **ADJUSTMENTS (BASE UNIT)** ()

14.2.2. Flow Solder Side View

Note:

(A) - (P) is referred to **ADJUSTMENTS (BASE UNIT)** ()

15. ADJUSTMENTS (HANDSET)

If your unit have below symptoms, adjust or confirm each item using remedy column from the table.

Symptom	Remedy
The movement of Battery Low indicator is wrong.	Make confirmation in item (F)~(G)
The handset does not respond to a call from base unit.	Make adjustments in item (H), (J)~(N)
The handset does not transmit or the transmit frequency is off.	Make adjustments in item (H)~(K), (M)
The transmit frequency is off.	Make confirmation in item (H)~(K), (M)
The transmit power output is low, and the operating distance between base unit and handset is less than normal.	Make confirmation in item
The reception sensitivity of base unit is low with noise.	Make confirmation in item
Dose not link between base unit and handset.	Make confirmation in item (H)~(N)
The reception level is high or low.	Make adjustments in item
The transmit level is high or low.	Make adjustments in item

* : Refer to **Adjustment** ()

15.1. Adjustment

	Items	Adjustment Point	Procedure*													
(A)	4.0V Supply Confirmation	-	1. Confirm that the consumption current is < 200mA , that is, there is no short circuit. 2. Confirm that the voltage between TP14 and GND is 4.1V ± 0.2V.	I F E C F C												
(B)	VBACK Status Confirmation	-	1. Confirm that the voltage between TP18 and GND is 0V ± 0.4V.	I F E C F C												
(C)	BBIC Selftest	-	1. BBIC Selftest (Execute the command "getchk"). 2. Confirm the returned checksum value. Connection of checksum value and program number is shown below. <table><tr><th>checksum value</th><th>program number</th></tr><tr><td>8181</td><td>D241AA</td></tr><tr><td>B794</td><td>D241ZA</td></tr><tr><td>D8C3</td><td>D241ZB</td></tr><tr><td>A00E</td><td>D241ZC</td></tr><tr><td>AA80</td><td>D241ZD</td></tr></table>	checksum value	program number	8181	D241AA	B794	D241ZA	D8C3	D241ZB	A00E	D241ZC	AA80	D241ZD	I
checksum value	program number															
8181	D241AA															
B794	D241ZA															
D8C3	D241ZB															
A00E	D241ZC															
AA80	D241ZD															

	Items	Adjustment Point	Procedure*	
(D)	Charge Control Check & Charge Current Monitor Confirmation	-	1. Apply 6V between TP5(+) and TP6(-) with current limit of PSU to 200mA. 2. Confirm that the charge current is ON/OFF. 3. SW to decrease current limit of PSU to 100mA. 4. Confirm that the charge current is stable.	I I F C
(E) *	Charge Detection (OFF) Confirmation	-	1. Stop supplying 6V to TP5(+) and TP6(-). 2. Execute the command "charge". 3. Confirm that the returned value is 0x00 (hex).	I I F C
(F) *	Battery Monitor Confirmation	-	1. Apply $2.3V \pm 0.005V$ between TP3(+) and TP4(-). 2. Execute the command "readbatt". 3. Subtract "0x06" from returned value which define "XX" and confirm that the "XX" is 0x92 ~ 0xA2 (hex). 4. Execute the command "WRTBAT2 XX".	I I F C
(G)	Battery low Confirmation	-	1. Apply 2.40V between TP3(+) and TP4(-). 2. Confirm that there is no Speaker sound (Battery low alarm). 3. Apply 2.20V between TP3(+) and TP4(-). 4. Confirm that there is Speaker sound (Battery low alarm).	I R C C
(H) *	BBIC Clock Adjustment	TP19	1. Execute the command "conttx". 2. Adjust the frequency of TP19 executing the command "setfreq 00 xx (where xx is the value)" so that the reading of the frequency counter is $10.368000MHz \pm 0.000003Hz$.	I K

	Items	Adjustment Point	Procedure*
(I)*	Transmitted Power Confirmation	TP15	Remove the Antenna before starting step from 1 to 5. 1. Configure the DECT tester(CMD60) as follows; <Setting> -Testmode: PP -RFPI: 0102030405 -Traffic Channel: 5 -Traffic Slot: 4 -Mode: Loopback 2. Execute the command "testmode". 3. Execute the command "regcmd60" 4. Initiate connection from DECT tester. 5. Confirm that the NTP value at A201 (TP15) is 20dBm ~ 25dBm
(J)	Modulatoin Check and Adjusment	TP15	Follow steps 1 to 4 of (I) above. 1. Confirm that the B-Field Modulation is 340kHz/div ~ 402kHz/div using data type Fig31. 2. Adjust the B-Field Modulation if required. (Execute the command "Readmod" and "Writemod xx", where xx is the value.)
(K)	Frequency Offset Confirmation	-	Follow steps 1 to 4 of (I) above. 1. Confirm that the frequency offset is $< \pm 40\text{kHz}$.

	Items	Adjustment Point	Procedure*
(L)	Sensitivity Receiver Confirmation	-	Follow steps 1 to 4 of (I) above. 1. Set DECT tester power to -88dBm. 2. Confirm that the BER is < 1000ppm.
(M)	Timing Confirmation	-	Follow steps 1 to 4 of (I) above. 1. Confirm that the Timing accuracy is < ± 10ppm.
(N) *	RSSI Level Confirmation	-	Follow steps 1 to 4 of (I) above. 1. Set DECT tester power to -88dBm. 2. Execute the command "readrssi" 3. Confirm that the returned value is 0x34 ± A (hex).

	Items	Adjustment Point	Procedure*
(O) *	Receive Audio Check and Adjustment	TP15	1. Configure the DECT tester (CMD60) as follows; <Setting> -Testmode: PP -Mode: Nomal -RFPI: 0102030405 2. Execute the command "testmode". 3. Execute the command "regcmd60". 4. Initiate connection from DECT tester. 5. Execute the command "openaudio". 6. Confirm that the value of EEPROM address "F3F" is "02". (If the value is not "02", set "02" and power off and power on, and return to clause 2.) 7. Input audio signal (50mVrms/1kHz tone) from DECT tester. <DECT tester setting> -Scramble: On -AF Gen to ADPCM: On -AF Meter Input: AF Voltm -AF Gen Frequency: 1000Hz -AF Gen Level: 50mVrms 8. Confirm hearing tone: 300mV ± 250mV (Just check Audio path) 9. Confirm that the audio distortion with DECT tester is < 5 %.
(P)	Transmit Audio Check and Adjustment	TP15	1. Configure the DECT tester (CMD60) as follows; <Setting> -Testmode: FP -Mode: Normal -RFPI: 0102030405 2. Execute the command "testmode". 3. Execute the command "regcmd60". 4. Initiate connection from DECT tester. 5. Execute the command "openaudio". 6. Confirm that the value of EEPROM address "F3F" is "02". (If the value is not "02", set "02" and power off and power on, and return to clause 2.) 7. Input audio signal (30mVrms/1kHz tone) to from DECT tester. <DECT tester setting> -Scramble: On -AF Gen to ADPCM: Off -AF Meter Input: ADPCM -AF Gen Frequency: 1000Hz -AF Gen Level: 30mVrms 8. Confirm hearing tone: 300mV ± 250mV (Just check Audio path) 9. Confirm that the audio distortion with DECT tester is < 5 %.

Note:

After the measuring, sock up the solder of TP.

* : **PC Setting** () is required beforehand.

The connection of adjustment equipment are as shown in **Adjustment Standard (Handset)** ().

15.2. Adjustment Standard (Handset)

When connecting the Simulator Equipments for checking, please refer to below.

Note:

(A) - (P) is referred to [ADJUSTMENTS \(HANDSET\)](#) ()

16. RF SPECIFICATION

16.1. Base Unit

Item	Value	Refer to -. *	Remar
TX Power	More than 20 dBm ~ 25 dBm	Adjustment (H)	
Modulation	340 kHz/div ~ 402 kHz/div	Adjustment (I)	Data type:
Frequency Offset	-40 kHz ~ +40 kHz	Adjustment (J)	
RX Sensitivity	< 1000 ppm	Adjustment (K)	
Timing Accuracy	< ± 5.0 ppm	Adjustment (L)	
RSSI Level	0x34 hex ± A hex	Adjustment (M)	

* : Refer to [Adjustment](#) ()

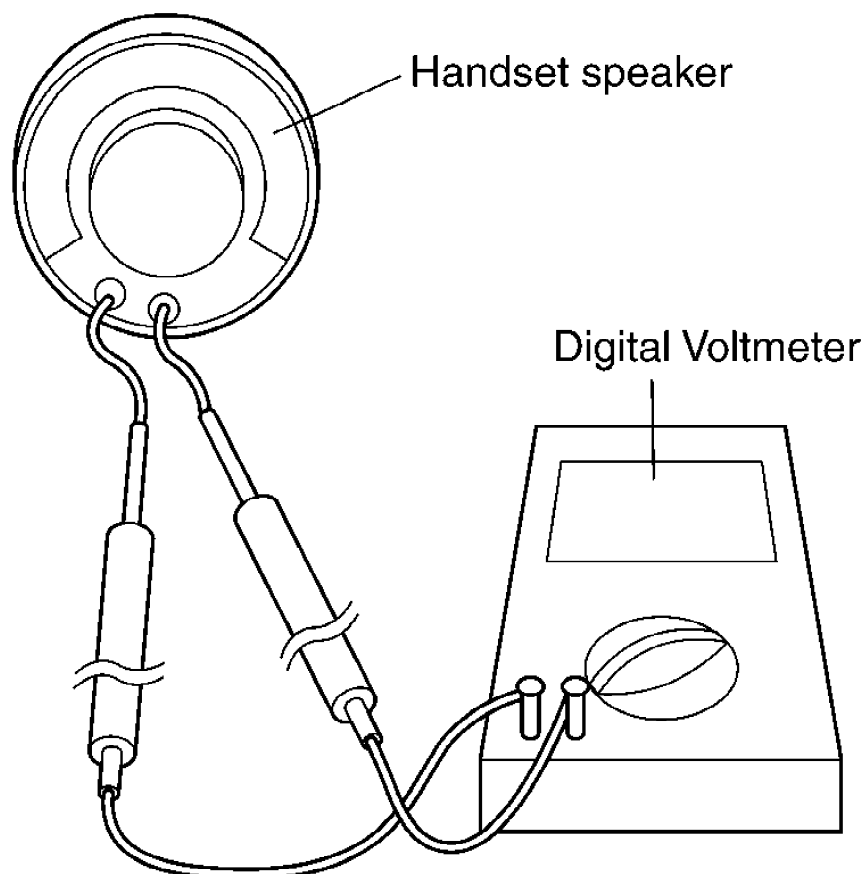
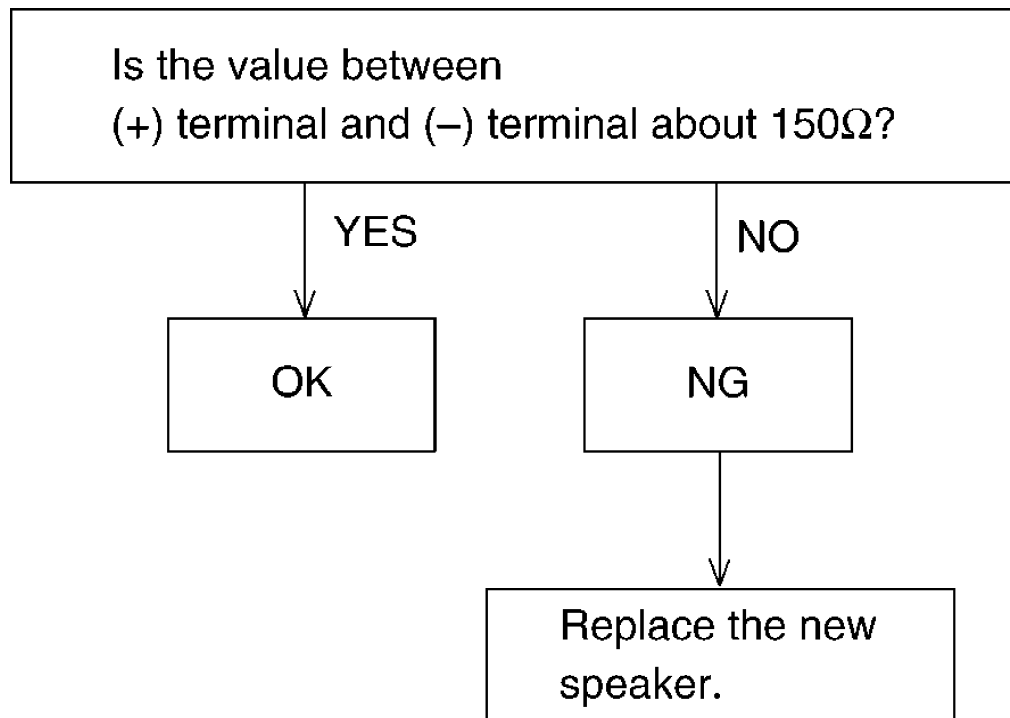
16.2. Handset

Item	Value	Refer to -. **	Remar
TX Power	More than 20 dBm ~ 25 dBm	Adjustment (I)	
Modulation	340 kHz/div ~ 402 kHz/div	Adjustment (J)	Data type:
Frequency Offset	-40 kHz ~ +40 kHz	Adjustment (K)	
RX Sensitivity	< 1000 ppm	Adjustment (L)	
Timing Accuracy	< ± 10 ppm	Adjustment (M)	
RSSI Level	0x34 hex ± A hex	Adjustment (N)	

** : Refer to [Adjustment](#) ()

17. HOW TO CHECK THE HANDSET SPEAKER

1. Prepare the digital voltmeter, and set the selector knob to ohm meter.
2. Put the probes at the speaker terminals as shown below.



18. FREQUENCY TABLE (MHz)

Channel No	BASE UNIT		HANDSET	
	Transmit Frequency	Receive Frequency	Transmit Frequency	Receive Fr
1	1897.344	1897.344	1897.344	1897.3
2	1895.616	1895.616	1895.616	1895.6
3	1893.888	1893.888	1893.888	1893.8
4	1892.160	1892.160	1892.160	1892.1
5	1890.432	1890.432	1890.432	1890.4
6	1888.704	1888.704	1888.704	1888.7
7	1886.976	1886.976	1886.976	1886.9
8	1885.248	1885.248	1885.248	1885.2
9	1883.520	1883.520	1883.520	1883.5
10	1881.792	1881.792	1881.792	1881.7

Note:

Channel No. 10: In the Test Mode on Base Unit and Hnadset.

19. BLOCK DIAGRAM (BASE UNIT)

20. CIRCUIT OPERATION (BASE UNIT)

20.1. Outline

Base Unit consists of the following ICs as shown in **BLOCK DIAGRAM (BASE UNIT)** ().

- DECT BBIC (Base Band IC): IC2
- Handling all the audio, signal and data processing needed in a DECT base unit
- Controlling the DECT specific physical layer and radio section (Burst Module Controller section)
- ADPCM codec filter for speech encoding and speech decoding (DSP section)
- Echo-cancellation and Echo-suppression (DSP section)
- Any tones (tone, sidetone, ringing tone, etc.) generation (DSP section)
- DTMF receiver (DSP section)
- Clock Generation for RF Module
- ADC, DAC, timer, and power control circuitry
- All interfaces (ex: RF module, EEPROM, LED, Analog Front End, etc.)
- RF Module: IC3
- PLL Oscillator

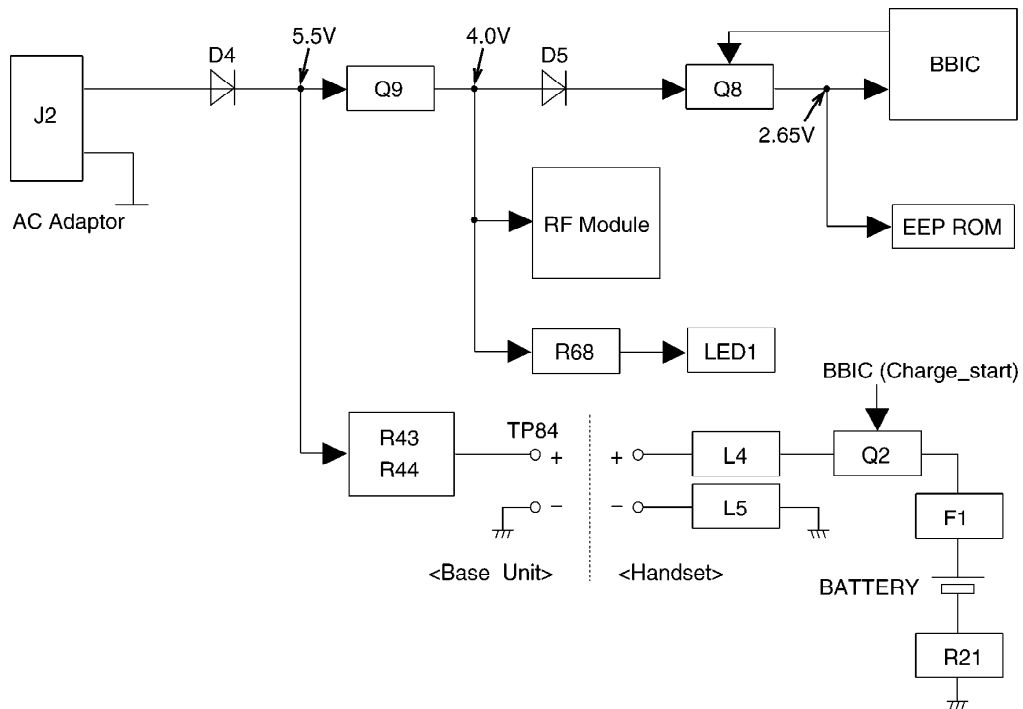
- Detector
- Compress/Expander
- First/Second Mixer
- Amplifier for transmission and reception
- EEPROM: IC1
- Temporary operating parameters (for RF, etc.)
- Additionally,
- Power Supply Circuit (+4.0V, +2.65V output)
- Crystal Circuit (10.368MHz)
- Charge Circuit
- Telephone Line Interface Circuit

20.2. Power Supply Circuit

The power is supplied to the DECT BBIC, RF Module, EEPROM, Relay Coil, LED and Charge Contact from AC Adaptor (+6V) as shown in Fig.101. The power supply is as follows;

- DECT BBIC (IC2): J2(+6V) → D4 → Q9 → D5 → Q8 → IC2
- RF Module (IC3): J2(+6V) → D4 → Q9 → IC3
- EEPROM (IC1): J2(+6V) → D4 → Q9 → D5 → Q8 → IC2 → IC1
- LED (LED1): J2(+6V) → D4 → Q9 → R68 → LED1
- Charge Contact (TP84): J2(+6V) → D4 → R43, R44 → TP84

<Fig.101>



20.3. Telephone Line Interface

<Function>

- Bell signal detection
- Clip signal detection
- ON/OFF hook circuit
- Metering Pulse circuit
- Audio circuits

Bell & Clip (: Calling Line Identification Presentation: Caller ID) signal detection:

In the standby mode, Q2 is open to cut the DC loop current and decrease the ring load.

When ring voltage appears at the TP3 (A) and TP40 (B) leads (when the telephone rings), the signal is transferred as follows;

- A → C4 → R2 → R29 → IC2 (DLP) [BELL & CLIP]
- B → C3 → R1 → R30 → IC2 (DLP) [BELL & CLIP]

ON/OFF hook circuit:

In the standby mode, Q2 is open, and connected as to cut the DC loop current and to cut the voice signal. The unit is consequently in an off-hook condition.

When IC2 detects a ring signal or press the TALK Key onto the handset, Q3 turns on and then Q2 turns on, thus providing an off-hook condition (active DC current flow through the circuit) and the following signal flow is for the loop current.

- A → R77 → D2 → Q2 → R8 → Q3 → D2 → B [OFF HOOK]

20.4. Transmitter/Receiver

Base Unit and Handset mainly consist of RF Module and DECT BBIC.

Base Unit and Handset transmit/receive voice signal and data signal through the antenna on carrier frequency.

Signal Pass:

*Refer to **SIGNAL ROUTE** ().

20.4.1. Transmitter Block

The voice signal input from the TEL LINE interface goes to RF Module (IC3) through DECT BBIC (IC2) as shown in **BLOCK DIAGRAM (BASE UNIT)** ().

The voice signal passes through the analog part of IC2 where it is amplified and converted to a digital audio stream signal. The burst switch controller processes this stream performing encryption and scrambling, adding the various other fields to produce DECT frame, assigning to a time slot and channel etc.

In IC3, the carrier frequency is changing, and frequency modulated RF signal is generated and amplified, and radiated from antenna. Handset detects the voice signal or data signal in the circuit same as the following explanation of Receiver Block.

20.4.2. Receiver Block

The signal of 19.2 MHz band (18.81792 MHz ~ 18.97344 MHz) which is input from antenna is input to IC3 as shown in **BLOCK DIAGRAM (BASE UNIT)** ().

In IC3, the signal of 19.2 MHz band is downconverted to 864 kHz signal and demodulated, and goes to IC2 as DECT frames. It passes through the decoding section burst switch controller where it separates out the frame information and performs de-encryption and de-scrambling as required. It then goes to the DSP section where it is turned back into analog audio. This is amplified by the analog front end, and goes to the TEL LINE Interface.

21. BLOCK DIAGRAM (HANDSET)

22. CIRCUIT OPERATION (HANDSET)

22.1. Outline

Handset consists of the following ICs as shown in **BLOCK DIAGRAM (HANDSET)** ().

- DECT BBIC (Base Band IC): IC1
- All data signals (forming/analyzing ACK or CMD signal)
- All interfaces (ex: Key, Detector Circuit, Charge, DC/DC Converter, EEPROM, LCD)

- RF Module: IC3
- PLL Oscillator
- Detector
- Compress/Expander
- Amplifier for transmission and reception

22.2. Power Supply Circuit/Reset Circuit

Circuit Operation:

When power on the Handset, the voltage is as follows;

BATTERY(2.2 V ~ 2.6V: TP3) → TP14(4V) → IC3(6, 27), D3 → IC1(37) → IC1(39, 63) (2.65V)

The Reset signal generates R19, C23 and 2.65V.

22.3. Charge Circuit

Circuit Operation:

When charging the handset on the Base Unit, the charge current is as follows;

DC+(5.5V ~ 6V) → D4 → R43, R44 → CHARGE+(Base) → CHARGE+(Handset) → L4 → Q2 → F1 → BATTERY+ ... Battery ... BATTERY- → R21 → GND → L5 → CHARGE-(Handset) → CHARGE-(Base) → GND → DC-(GND)

In this way, the BBIC on Handset detects the fact that the battery is charged.

The charge current is controlled by switching Q2 of Handset.

Refer to Fig.101 in [Power Supply Circuit](#) ().

22.4. Battery Low/Power Down Detector

Circuit Operation:

"Battery Low" and "Power Down" are detected by BBIC which check the voltage from battery.

The detected voltage is as follows;

- Battery Low

Battery voltage: $V(\text{Batt}) < 2.3\text{V}$

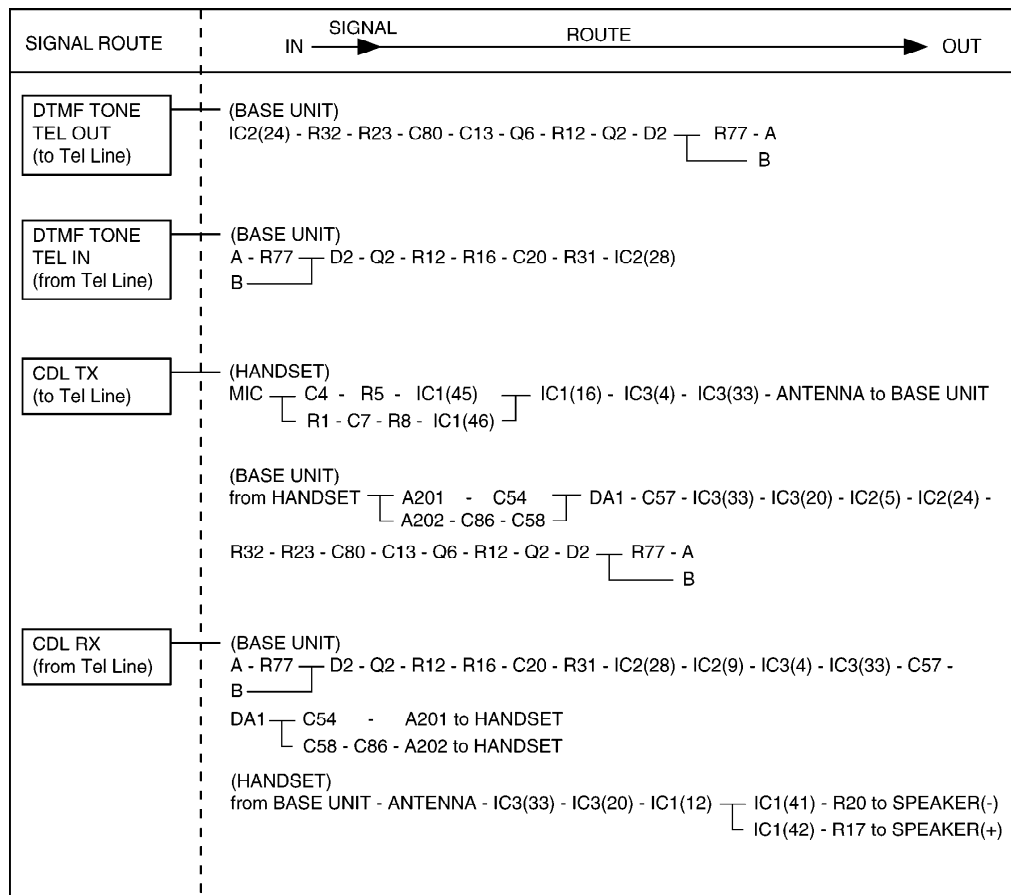
The BBIC detects this level and " starts flashing and "battery alarm" starts ringing.

- Power Down

Battery voltage: $V(\text{Batt}) < 2.2\text{V}$

The BBIC detects this level and power down.

23. SIGNAL ROUTE



24. CPU DATA (BASE UNIT)

24.1. IC2 (BBIC)

Pin	Description	I/O	Hi	Hi-z	Low	Remarks
1	VDD	-	-	-	-	-
2	VSS	-	-	-	-	-
3	PA_Driver_Amp	D.O	PA_ON	-	PA_OFF	-
4	TX/RX SW	D.O	TX	-	RX	-
5	RX_Data	D.I	Data	-	Data	-
6	PLL_Strobe	D.O	Latch	-	Normal	-
7	PLL_Data	D.O	Active	-	Active	-
8	PLL_Clk	D.O	Active	-	Active	-
9	TX_Data	D.O	Active	-	Active	-
10	(NO USE)	D.O	-	-	-	-
11	RF_System_Clk	D.O	Active	-	Active	-
12	VDD	-	-	-	-	-
13	VSS	-	-	-	-	-
14	RESETQ	A.I	Normal	-	Reset	-
15	VDDPM	D.O	-	-	-	-
16	VSSO	D.I	-	-	-	-
17	LOAD	A.I	-	-	-	-
18	XTAL	A.I	-	-	-	10.368 MHz
19	VDDL	A.I	-	-	-	-
20	LRB	A.I	-	-	-	-
21	VDDA	-	-	-	-	-
22	VSSA	-	-	-	-	-
23	Audio_Out_N	A.O	-	-	-	-
24	Audio_Out_P	A.O	-	-	-	-
25	Bandgap_Ref	A.I	-	-	-	-
26	Differential_Line_P	A.I	-	-	-	for Bell Clip
27	Differential_Line_N	A.I	-	-	-	for Bell Clip
28	Audio_In_N	A.I	-	-	-	-
29	ADC_Ref	A.I	-	-	-	-
30	RSSI	A.I	-	-	-	-
31	AD2(MPCINP)	A.I	-	-	-	for Polarity
32	AD3	A.I	-	-	-	for Polarity
33	(NO USE)	D.I	(I_PU)	-	-	-
34	(NO USE)	D.I	(I_PU)	-	-	-
35	(NO USE)	D.I	(I_PU)	-	-	-
36	(NO USE)	D.I	(I_PU)	-	-	-
37	VDD	-	-	-	-	-
38	VSS	-	-	-	-	-
39	Supply_EEP	D.O	(Fixed)	-	-	-
40	Serial_Data(I2C)	D.I/O	Data	-	Data	-
41	Serial_Clk(I2C)	D.O	Active	-	Active	-
42	MODE	D.I	-	-	(Fixed)	-
43	(NO USE)	D.O	-	-	(Fixed)	-
44	BELL/ PAGING_LED	D.O	LED_ON	-	LED_OFF	-

Pin	Description	I/O	Hi	Hi-z	Low	Remarks
45	VBACK	A.I	-	-	-	-
46	(NO USE)	-	-	-	(I_PD)	-
47	(NO USE)	D.I	-	-	(Fixed)	-
48	VDD	-	-	-	-	-
49	(NO USE)	D.I	-	-	(Fixed)	-
50	(NO USE)	D.I	(Fixed)	-	-	-
51	(NO USE)	D.I	-	-	(Fixed)	-
52	(NO USE)	D.I	-	-	(Fixed)	-
53	VSS	-	-	-	-	-
54	VDD	-	-	-	-	-
55	KEY_IN	D.I	No Key	-	Key	-
56	(NO USE)	D.I/O	-	-	(I_PD)	-
57	(NO USE)	D.I/O	-	-	(I_PD)	-
58	(NO USE)	D.I/O	-	-	(I_PD)	-
59	(NO USE)	D.I/O	-	-	(I_PD)	-
60	(NO USE)	D.I/O	-	-	(I_PD)	-
61	HOOK_CTRL	D.O	Make	-	Break	-
62	(NO USE)	D.I/O	-	-	(I_PD)	-
63	ANT1	D.O	ANT1_ON	-	ANT1_OFF	-
64	ANT2	D.O	ANT2_ON	-	ANT2_OFF	-

Note:

I_PU; Internal Pull-Up, I_PD; Internal Pull-Down

25. CPU DATA (HANDSET)

25.1. IC1 (BBIC)

Pin	Description	I/O	Hi	Hi-z	Remarks
1	LCD_SEGMENT	D.O	Active	-	-
2	LCD_COMMON	D.O	Active	-	-
3	VDD	-	-	-	-
4	VSS	-	-	-	-
5	LCD_COMMON	D.O	Active	-	-
6	LCD_COMMON	D.O	Active	-	-
7	LCD_COMMON	D.O	Active	-	-
8	LCD_COMMON	D.O	Active	-	-
9	LCD_COMMON	D.O	Active	-	-
10	PA_SW	D.O	PA ON	-	-
11	T/R SW	D.O	Transmit	-	-
12	RX_DATA	D.I	Active	-	-
13	SYEN	D.O	Active	-	-
14	SYDA	D.O	Active	-	-
15	SYCL	D.O	Active	-	-
16	TX_DATA	A.O	Active	-	-
17	KEY_IN	D.I	No Key	-	-
18	KEY_IN	D.I	No Key	-	-
19	KEY_IN	D.I	No Key	-	-
20	KEY_IN	D.I	No Key	-	-
21	KEY_IN	D.I	No Key	-	-
22	(NO USE)	D.O	-	-	-
23	Reference clock	D.O	Active	-	-
24	VDD	-	-	-	-
25	VSS	-	-	-	-
26	POWER_SW	A.I	No Key	-	-
27	CHARGE_DET	A.I	Charge	-	-
28	DCDCDRV	D.O	Active	-	-
29	DCDCCMR	A.I	-	-	-
30	RESET	A.I	Normal	-	-
31	VSSO	-	-	-	-
32	LOAD	A.I	-	-	-
33	XTAL	A.I	-	-	-
34	VDDPM	A.O	-	-	-
35	VDDL0	A.O	-	-	-
36	VDDBAT	A.I	-	-	-
37	VDDLr	-	-	-	-
38	CHARGE_START	A.O	-	-	for charge
39	VDDA	-	-	-	-
40	VSSA	-	-	-	-
41	LSRN	A.O	-	-	-
42	LSRP	A.O	-	-	-
43	BANDGAP_REF	A.O	-	-	-
44	MICS	A.O	-	-	-
45	MICP	A.I	-	-	-

43	IMCP	A.I	-	-	-
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Pin	Description	I/O	Hi	Hi-z	Remarks
46	MICN	A.I	-	-	-
47	Reference Voltage	A.O	-	-	-
48	RSSI	A.I	-	-	-
49	P0.4	D.I	-	-	-
50	AD4N	A.I	-	-	-
51	AD4P	A.I	-	-	-
52	(NO USE)	D.I	-	-	-
53	KEY_STRB	D.O	Active	-	-
54	KEY_STRB	D.O	Active	-	-
55	KEY_STRB	D.O	Active	-	-
56	LCD_SEGMENT	D.O	Active	-	-
57	LCD_SEGMENT	D.O	Active	-	-
58	LCD_SEGMENT	D.O	Active	-	-
59	KEY_STRB	D.O	Active	-	-
60	KEY_STRB	D.O	Active	-	-
61	LCD_SEGMENT	D.O	Active	-	-
62	LCD_SEGMENT	D.O	Active	-	-
63	VDD	-	-	-	-
64	VSS	-	-	-	-
65	VDD for EEPROM	D.O	-	-	-
66	I2DAT	D.I/O	Active	-	-
67	I2CLK	D.I/O	Active	-	-
68	MODE	D.I	-	-	-
69	R2	D.I	-	-	-
70	(NO USE)	D.O	-	-	-
71	VBACK/P0.7	D.I	-	-	-
72	LCD_SEGMENT	D.O	Active	-	-
73	LCD_SEGMENT	D.O	Active	-	-
74	LCD_SEGMENT	D.O	Active	-	-
75	LCD_SEGMENT	D.O	Active	-	-
76	LCD_SEGMENT	D.O	Active	-	-
77	VDDLI	-	-	-	-
78	LCD_SEGMENT	D.O	Active	-	-
79	LCD_SEGMENT	D.O	Active	-	-
80	LCD_SEGMENT	D.O	Active	-	-
81	LCD_SEGMENT	D.O	Active	-	-
82	LCD_SEGMENT	D.O	Active	-	-
83	LCD_SEGMENT	D.O	Active	-	-
84	LCD_SEGMENT	D.O	Active	-	-
85	VSS	-	-	-	-
86	VDD	-	-	-	-
87	LCD_SEGMENT	D.O	Active	-	-
88	(NO USE)	D.O		-	-

Pin	Description	I/O	Hi	Hi-z	Remarks
89	Power Select	D.O	Low Power	-	-
90	LCD_SEGMENT	D.O	Active	-	-
91	LCD_SEGMENT	D.O	Active	-	-
92	LCD_SEGMENT	D.O	Active	-	-
93	LCD_SEGMENT	D.O	Active	-	-
94	LCD_SEGMENT	D.O	Active	-	-
95	LCD_SEGMENT	D.O	Active	-	-
96	LCD_SEGMENT	D.O	Active	-	-
97	LCD_SEGMENT	D.O	Active	-	-
98	LCD_SEGMENT	D.O	Active	-	-
99	LCD_SEGMENT	D.O	Active	-	-
100	LCD_SEGMENT	D.O	Active	-	-

26. HOW TO REPLACE FLAT PACKAGE IC

26.1. Preparation

- PbF (: Pb free) Solder

- Soldering Iron

Tip Temperature of 700°F ± 20°F (370°C ± 10°C)

Note: We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

- Flux

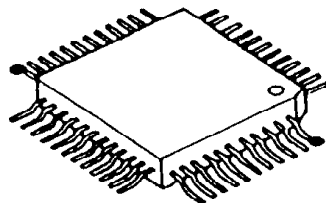
Recommended Flux: Specific Gravity → 0.82.

Type → RMA (lower residue, non-cleaning type)

Note: See [ABOUT LEAD FREE SOLDER \(PbF: Pb free\)](#) ().

26.2. Procedure

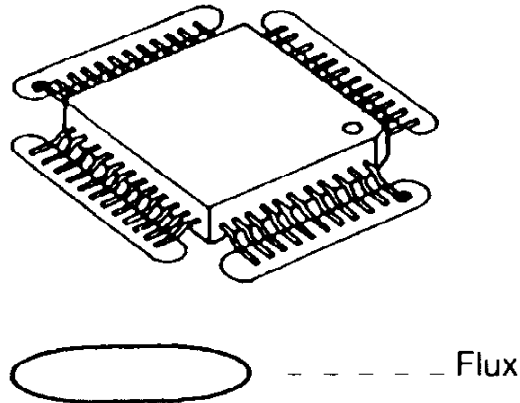
1. Tack the flat pack IC to the PCB by temporarily soldering two diagonally opposite pins in the correct positions on the PCB.



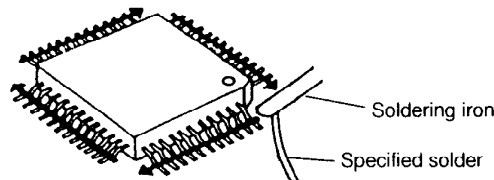
● - - - - - Temporary soldering point.

Be certain each pin is located over the correct pad on the PCB.

2. Apply flux to all of the pins on the IC.

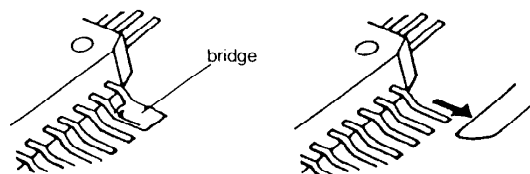


3. Being careful to not unsolder the tack points, slide the soldering iron along the tips of the pins while feeding enough solder to the tip so that it flows under the pins as they are heated.

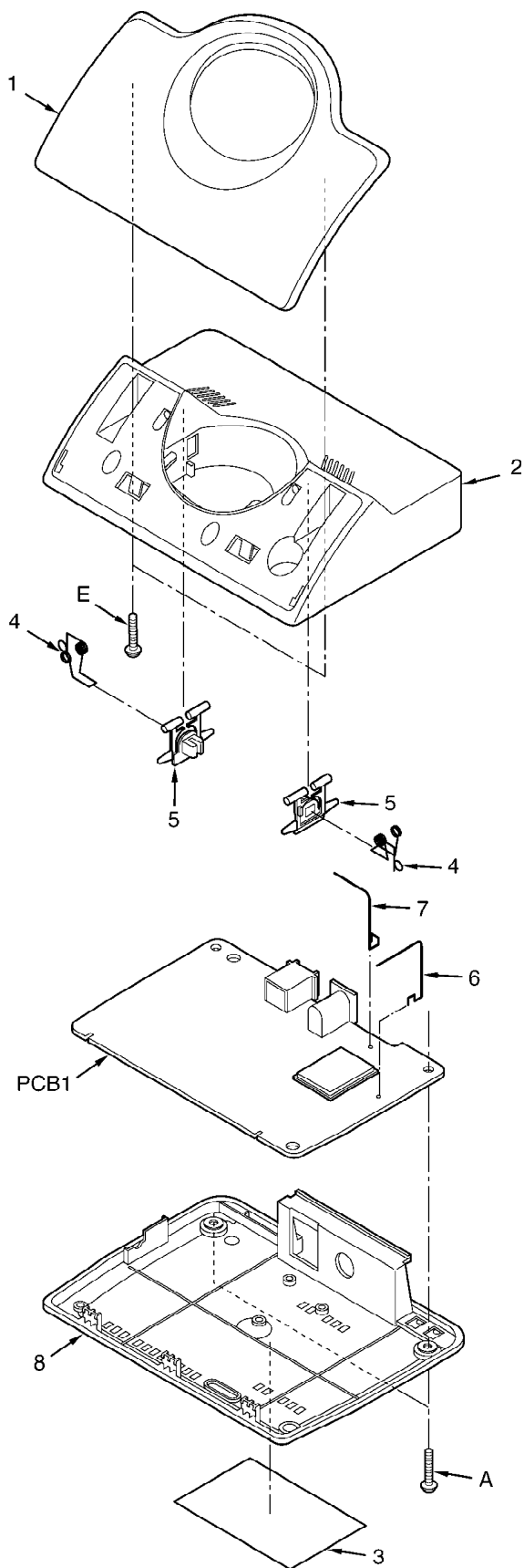


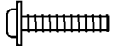
26.3. Modification Procedure of Bridge

1. Add a small amount of solder to the bridged pins.
2. With a hot iron, use a sweeping motion along the flat part of the pin to draw the solder from between the adjacent pads.



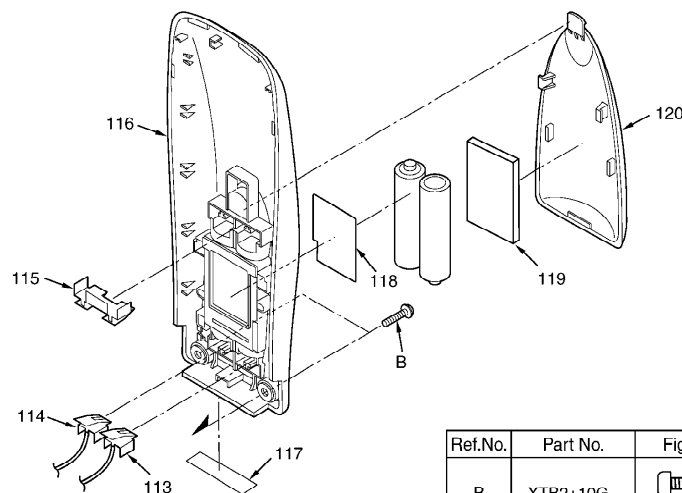
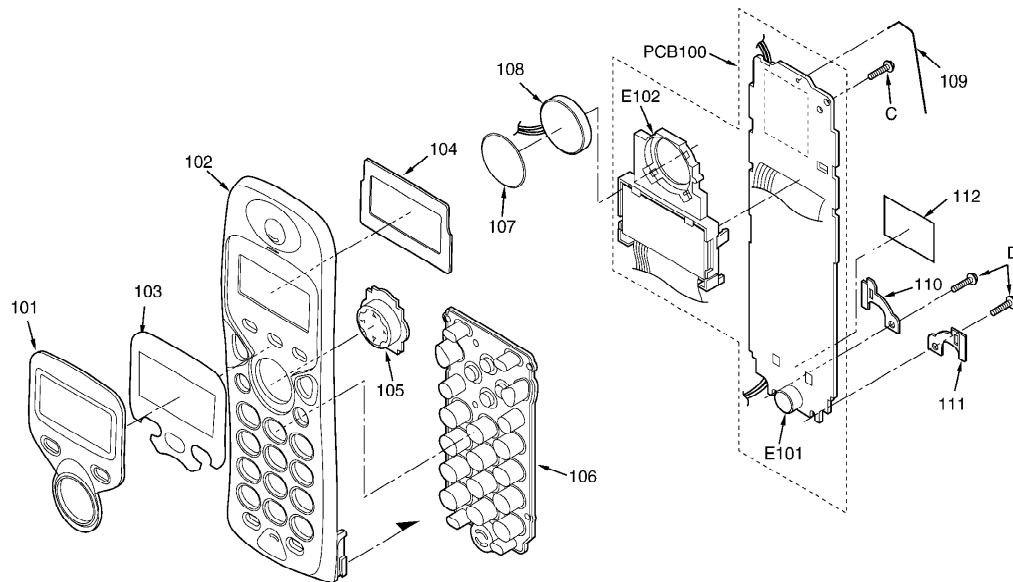
27. CABINET AND ELECTRICAL PARTS LOCATION (BASE UNIT)



Ref.No.	Part No.	Figure
A	XTW26+12P	 $\phi 2.6 \times 12\text{mm}$

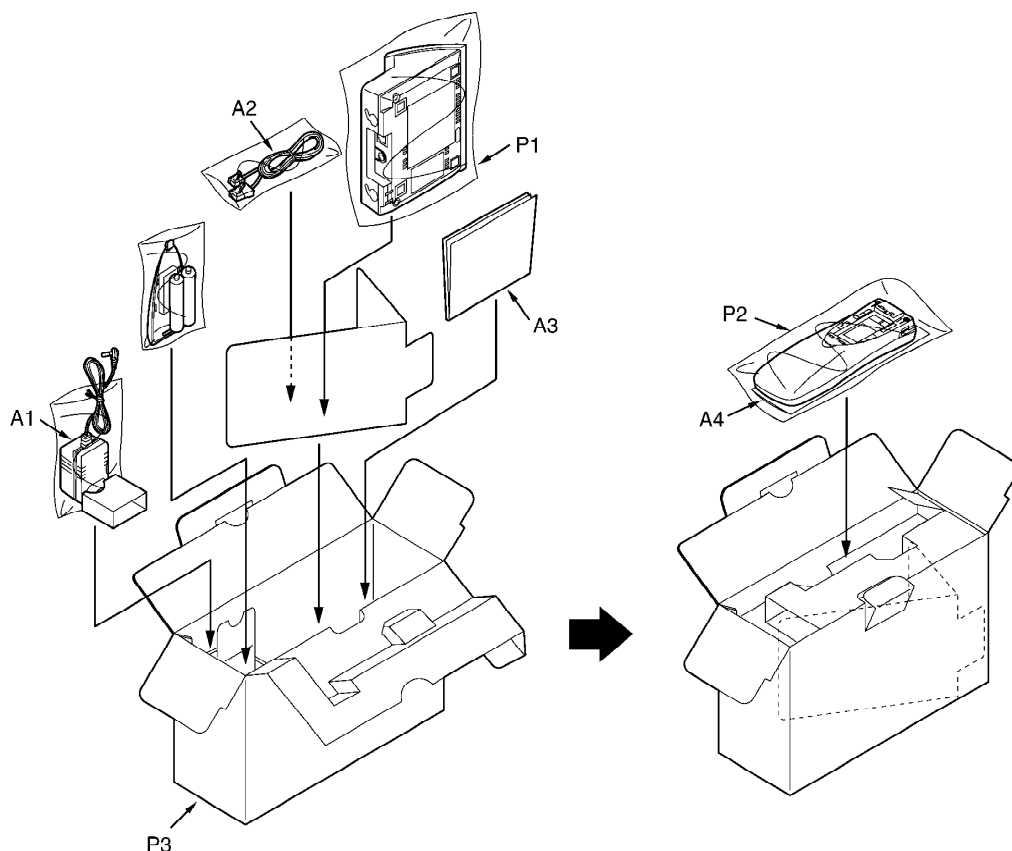
E	XTW26+12P	 φ2.6 × 12mm
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28. CABINET AND ELECTRICAL PARTS LOCATION (HANDSET)



Ref.No.	Part No.	Figure
B	XTB2+10G	 φ2 × 10mm
C	XTB2+8G	 φ2 × 8mm
D	XTB2+8G	 φ2 × 8mm

29. ACCESSORIES AND PACKING MATERIALS

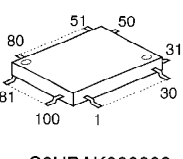
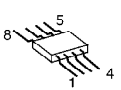
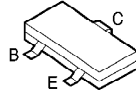
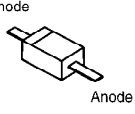
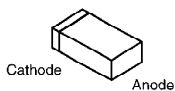


30. TERMINAL GUIDE OF THE ICs TRANSISTORS AND DIODES

30.1. Base Unit

PQVI24LC32AI	C2HBAK000001	PQVILM1117MP	2SA1625	PQVDS1ZB60F1
B1ADGE000004, PQVTBF822T7	MA1Z300	B0JAME000085	MA2Z74800L	
B0DDCM000001				

30.2. Handset

 C2HBAK000002	 PQVI24LC32AI	 PQVTFDN335N, B1ADGE000004 UN5216	 B0JCME000035
 MA2Z74800L MA8390MTX			

31. REPLACEMENT PARTS LIST

Note:

1. RTL (Retention Time Limited)

The marking (RTL) indicates that the Retention Time is limited for this item.

After the discontinuation of this assembly in production, the item will continue to be available for a specific period of time. The retention period of availability is dependant on the type of assembly, and in accordance with the laws governing part and product retention. After the end of this period, the assembly will no longer be available.

2. Important safety notice

Components identified by the  mark indicates special characteristics important for safety. When replacing any of these components, only use specified manufacture's parts.

3. The S mark means the part is one of some identical parts. For that reason, it may be different from the installed part.

4. RESISTORS & CAPACITORS

Unless otherwise specified;

All resistors are in ohms (Ω) K=1000 Ω , M=1000k Ω

All capacitors are in MICRO FARADS (μ F) P= μ μ F

*Type & Wattage of Resistor

Type					
ERC:Solid ERDS:Carbon ERJ:Chip		ERX:Metal Film ERG:Metal Oxide ER0:Metal Film		PQ4R:Chip ERS:Fusible Resistor ERF:Cement Resistor	
Wattage					
10,16:1/8W	14,25:1/4W	12:1/2W	1:1W	2:2W	3:3W
*Type & Voltage Of Capacitor					
Type					
ECFD:Semi-Conductor ECQS:Styrol ECUV,PQCUV,ECUE:Chip ECQMS:Mica		ECCD,ECKD,ECBT,F1K,ECUV: Ceramic ECQE,ECQV,ECQG: Polyester ECEA,ECST,EEE: Electlytic ECQP: Polypropylene			
Voltage					
ECQ Type	ECQG ECQV Type	ECSZ Type	Others		
1H:50V 2A:100V 2E:250V 2H:500V	05:50V 1:100V 2:200V	0F:3.15V 1A:10V 1V:35V 0J:6.3V	0J :6.3V 1A :10V 1C :16V 1E,25:25V	1V :35V 50,1H:50V 1J :16V 2A :100V	

31.1. Base Unit

31.1.1. Cabinet and Electrical Parts

Ref. No.	Part No.	Part Name & Description	Remarks
1	PQGG10154Z2	GRILLE (for KX-TCD400GC)	ABS-HB
1	PQGG10154Z1	GRILLE (for KX-TCD400GF)	ABS-HB
2	PQKM10586Y2	CABINET BODY (for KX-TCD400GC)	PS-HB
2	PQKM10586Y1	CABINET BODY (for KX-TCD400GF)	PS-HB
3	PQGT15738Z	NAME PLATE (for KX-TCD400GC)	
3	PQGT15635Z	NAME PLATE (for KX-TCD400GF)	
4	PQJT10203Z	TERMINAL	
5	PQKE10356Z1	GUIDE, CHARGE TERMINAL CASE	POM-HB
6	PQSA10131Z	ANTENNA, MAIN	
7	PQSA10132Z	ANTENNA, SUB	
8	PQYF10560Z2	CABINET COVER (for KX-TCD400GC)	PS-HB
8	PQYF10560Z1	CABINET COVER (for KX-TCD400GF)	PS-HB

31.1.2. Main P.C.Board Parts

Ref. No.	Part No.	Part Name & Description	Remarks
PCB1	PQWP1D400GH	MAIN P.C.BOARD ASS'Y (RTL)	
		(ICS)	
IC1	PQVI24LC32AI	IC	S
IC2	C2HBAK000001	IC	
IC3	J3FKK0000003	IC	
Q9	PQVILM1117MP	IC	S
		(TRANSISTORS)	
Q2	2SA1625	TRANSISTOR(SI)	S
Q3	PQVTBF822T7	TRANSISTOR(SI)	
Q8	B1ADGE000004	TRANSISTOR(SI)	
		(DIODES)	
D2	PQVDS1ZB60F1	DIODE(SI)	S
D3	MA1Z300	DIODE(SI)	
D4	B0JAME000085	DIODE(SI)	
D5	MA2Z74800L	DIODE(SI)	
DA1	B0DDCM000001	DIODE(SI)	
		(COILS)	
L1	PQLQR4D4R7K	COIL	
L3	PQLQR2M33NK	COIL	
		(JACKS)	
J1	PQJJ1TB26Z	JACK, MODULATOR	S
J2	K2EZ2B000040	JACK, DC	
		(RESISTORS)	
R1	ERJ3GEYJ155	1.5M	
R2	ERJ3GEYJ155	1.5M	
R3	ERJ3GEYJ224	220K	
R4	ERJ3GEYJ184	180K	
R5	ERJ3GEYJ224	220K	
R6	ERJ3GEYJ184	180K	
R7	ERJ3GEYJ104	100K	
R8	ERJ3GEYJ272	2.7K	
R9	ERJ3GEYJ103	10K	
R10	ERJ3GEYJ222	2.2K	
R12	PQ4R18XJ000	0	S
R16	ERJ3GEYJ133	13K	
R18	ERJ3GEYJ392	3.9K	
R19	ERJ12YJ220	22	
R20	ERJ12YJ560	56	
R21	ERJ3GEYJ104	100K	
R22	ERJ3GEYJ333	33K	
R23	ERJ3GEYJ560	56	
R25	ERJ3GEYJ391	390	
R28	ERJ3GEYJ751	750	
R29	ERJ3GEYJ101	100	
R30	ERJ3GEYJ101	100	
R31	ERJ3GEYJ101	100	
R32	ERJ3GEYJ560	56	
R36	ERJ3GEY0R00	0	
R38	ERJ3GEYJ330	33	
R41	ERJ3GEYJ101	100	
R42	ERJ3GEYJ221	220	
R43	ERJ1WYJ330	33	
R44	ERJ1WYJ330	33	
R52	ERJ3GEY0R00	0	

Ref. No.	Part No.	Part Name & Description	Remarks
R53	ERJ3GEYJ565	5.6M	
R54	ERJ3GEYJ184	180K	
R57	ERJ3GEYJ103	10K	
R58	ERJ3GEYJ103	10K	
R66	ERJ3GEYJ390	39	
R67	ERJ3GEYJ390	39	
R77	PQ4R10XJ000	0	S
R78	ERJ3GEYJ181	180	
R79	ERJ3GEYJ181	180	
R81	ERJ3GEYJ565	5.6M	
R82	ERJ3GEYJ184	180K	
R86	ERJ3GEY0R00	0	
R87	ERJ3GEY0R00	0	
R88	ERJ3GEY0R00	0	
C80	PQ4R10XJ000	0	S
C86	ERJ3GEY0R00	0	
		(CAPACITORS)	
C1	ECKD2H681KB	680P	S
C2	ECKD2H681KB	680P	S
C3	ECQE2223KF	0.022	
C4	ECQE2223KF	0.022	
C11	ECUV1H472KBV	0.0047	
C12	PQCUV1C474KB	0.47	
C13	PQCUV1A105KB	1	
C14	PQCUV1C224KB	0.22	
C15	ECEA1HKS100	10	S
C16	PQCUV1H154KR	0.15	
C18	ECUV1H100DCV	10P	
C19	ECUV1H100DCV	10P	
C20	ECUV1C104KBV	0.1	
C21	ECUV1H100DCV	10P	
C22	PQCUV1C224KB	0.22	
C23	ECUV1C104KBV	0.1	
C24	ECUV1C104KBV	0.1	
C25	ECEA1CKS100	10	S
C26	ECUV1C104KBV	0.1	
C27	ECUV1C104KBV	0.1	
C28	ECUV1C683KBV	0.068	
C29	ECUV1C683KBV	0.068	
C30	ECUV1H182KBV	0.0018	
C32	ECUV1H270JCV	27P	
C33	ECUV1H1R0CCV	1	
C34	ECUV1C104KBV	0.1	
C35	ECUV1H333KBV	0.033	S
C36	ECUV1C104KBV	0.1	
C37	ECUV1C104KBV	0.1	
C38	ECUV1C104KBV	0.1	
C40	ECEA1AKA101	100	
C41	ECEA0JKA101	100	
C43	ECUV1H100DCV	10P	
C48	ECUV1H330JCV	33P	
C49	ECUV1H103KBV	0.01	
C54	ECUV1H060DCV	6P	S
C55	ECUV1H100DCV	10P	

Ref. No.	Part No.	Part Name & Description	Remarks
C56	ECUV1H100DCV	10P	
C57	ECUV1H030CCV	3P	
C58	ECUV1H2R0CCV	2	
C66	ECUV1H2R0CCV	2	
C67	ECUV1A475KB	4.7	
C69	ECUV1H2R0CCV	2	
C72	ECUV1H2R0CCV	2	
C73	ECUV1H100DCV	10P	
C74	ECUV1H103KBV	0.01	
C75	PQCUV1H020CC	2P	
C76	ECUV1H060DCV	6P	S
C78	ECUV1H100DCV	10P	
		(OTHERS)	
SA1	PQVDDSS301L	VARISTOR (SURGE ABSORBER)	S
X1	H0D103500003	CRYSTAL OSCILLATOR	

31.2. Handset

31.2.1. Cabinet and Electrical Parts

Ref. No.	Part No.	Part Name & Description	Remarks
101	PQGP10225Z2	PANEL, LCD (for KX-TCD400GC)	AS-HB
101	PQGP10225Z1	PANEL, LCD (for KX-TCD400GF)	AS-HB
102	PQKM10587Z2	CABINET BODY (for KX-TCD400GC)	ABS-HB
102	PQKM10587Z1	CABINET BODY (for KX-TCD400GF)	ABS-HB
103	PQHS10553Z	TAPE, DOUBLE SIDE	
104	PQHS10554Z	SPACER, LCD	
105	PQBC10375Z1	PUSH BUTTON, NAVI	
106	PQSX10224S	KEYBOARD SWITCH, 20KEY (for KX-TCD400GC)	
106	PQSX10224T	KEYBOARD SWITCH, 20KEY (for KX-TCD400GF)	
107	PQHS10467Z	COVER, SP NET	
108	L0AD02A00016	SPEAKER	
109	PQSA10133Z	ANTENNA	
110	PQJT10204Z	TERMINAL (L)	
111	PQJT10205Z	TERMINAL(R)	
112	PQHX11202Z	INSULATOR	
113	PQJC10058Z	BATTERY TERMINAL (+)	
114	PQJC10057Z	BATTERY TERMINAL (-)	
115	PQJC10056Z	BATTERY TERMINAL	
116	PQKF10582Z2	CABINET COVER (for KX-TCD400GC)	ABS-HB
116	PQKF10582Z1	CABINET COVER (for KX-TCD400GF)	ABS-HB
117	PQGT15739Z	NAME PLATE (for KX-TCD400GC)	
117	PQGT15717Z	NAME PLATE (for KX-TCD400GF)	
118	PQHX11174Z	PLASTIC PARTS, BATTERY COVER SHEET	
119	PQHS10561Y	SPACER, BATTERY COVER	
120	PQKK10134Z2	LID, BATTERY (for KX-TCD400GC)	ABS-HB
120	PQKK10134Z1	LID, BATTERY (for KX-TCD400GF)	ABS-HB

31.2.2. Main P.C.Board Parts

Ref. No.	Part No.	Part Name & Description	Remarks
PCB100	PQWP1D400GR	MAIN P.C.BOARD ASS'Y (RTL)	
		(ICs)	
IC1	C2HBAK000002	IC	
IC2	PQVI24LC32AI	IC	S
IC3	J3FKK0000003	IC	
		(TRANSISTORS)	
Q1	PQVTFDN335N	TRANSISTOR(SI)	S
Q2	B1ADGE000004	TRANSISTOR(SI)	
Q3	UN5216	TRANSISTOR(SI)	
		(DIODES)	
D1	B0JCME000035	DIODE(SI)	
D3	MA2Z74800L	DIODE(SI)	
D4	MA8390MTX	DIODE(SI)	
D6	MA2Z74800L	DIODE(SI)	
D7	MA2Z74800L	DIODE(SI)	
		(COILS)	
L2	G1A470L00001	COIL	
L3	PQLQR4D4R7K	COIL	
L4	G1C100MA0072	COIL	
L5	G1C100MA0072	COIL	
F1	PQLQR2M5N6K	COIL	S
		(RESISTORS)	
R1	ERJ3GEYJ222	2.2K	
R2	ERJ8BQJR30	0.3	
R3	ERJ3GEYJ560	56	
R4	ERJ3GEYJ103	10K	
R5	ERJ3GEYJ331	330	
R6	ERJ3GEYJ332	3.3K	
R7	ERJ3GEYJ331	330	
R8	ERJ3GEYJ331	330	
R11	ERJ3GEY0R00	0	
R17	ERJ3GEY0R00	0	
R18	ERJ3GEYJ330	33	
R19	ERJ3GEYJ153	15K	
R20	ERJ3GEY0R00	0	
R21	ERJ6RSJR10V	0.1	
R22	ERJ3GEY0R00	0	
R23	ERJ3GEYJ2R2	2.2	
R24	ERJ3GEY0R00	0	
		(CAPACITORS)	
C2	ECUV1A475KB	4.7	
C3	ECUV1C104KBV	0.1	
C4	ECUV1C104KBV	0.1	
C5	ECST0JY475	4.7	
C6	ECUV1H100DCV	10P	
C7	ECUV1C104KBV	0.1	
C8	ECUV1H100DCV	10P	
C10	ECUV1H100DCV	10P	
C11	ECUV1H100DCV	10P	
C12	ECUV1H100DCV	10P	
C14	EEE1AA221P	220	
C15	EEE1AA221P	220	
C16	ECUV1H1R0CCV	1	
C17	ECUV1H180JCV	18P	

Ref. No.	Part No.	Part Name & Description	Remarks
C18	ECUV1C104KBV	0.1	
C20	ECUV1C104KBV	0.1	
C21	ECUV1C104KBV	0.1	
C22	ECUV1C104KBV	0.1	
C23	ECUV1C104KBV	0.1	
C24	ECUV1C104KBV	0.1	
C26	ECUV1C104KBV	0.1	
C27	ECUV1C104KBV	0.1	
C28	ECUV1C104KBV	0.1	
C29	ECUV1C104KBV	0.1	
C30	ECUV1C104KBV	0.1	
C31	ECUV1H100DCV	10P	
C33	ECUV1A225KB	2.2	
C54	ECUV1H100DCV	10P	
C55	ECUV1H020CCV	2P	
C56	ECUV1H020CCV	2P	
C57	ECUV1H330JCV	33P	
C60	ECUV1A475KB	4.7	
C62	ECUV1A105KBV	1	
C63	ECUV1H100DCV	10P	
C64	ECUV1A105KBV	1	
C65	ECUV1H020CCV	2P	
C66	ECUV1H020CCV	2P	
		(OTHERS)	
E101	L0CBAB000052	MICROPHONE	
E102	PQWLA141E	LCD ASS'Y	
X1	H0D103500002	CRYSTAL OSCILLATOR	

31.3. Accessories and Packing Materials

Ref. No.	Part No.	Part Name & Description	Remarks
A1	PQLV200CEZ	AC ADAPTOR	⚠
A2	PQJA10139Z	CORD, TELEPHONE	
A3	PQQX13611Y	INSTRUCTION BOOK	
A4	PQQW12846W	LEAFLET, RECHARGE	
P1	PQPP10100Z	PROTECTION COVER (for Base Unit)	
P2	PQPP10084Z	PROTECTION COVER (for Handset)	
P3	PQPK13980Z	GIFT BOX	

31.4. Fixtures and Tools

Part No.	Part Name & Description	Remarks
PQZZTCD705BX	I2C PCB	
PQZZ1CD705BX	RS232C CABLE	
PQZZ2CD705BX	CLIP CABLE	
PQZZ3CD705BX	DC CABLE	
PQZZTCD410E	BATCH FILE	

Note:

See **CHECK PROCEDURE (BASE UNIT) ()**, and **CHECK PROCEDURE (HANDSET) ()**.

32. EEPROM LAYOUT (BASE UNIT)

32.1. Scope

The purpose of this section is to describe the layout of the EEPROM (IC1) for the KX-TCD400 Base Unit.

The EEPROM contains hardware, software, and user specific parameters. Some parameters are set during production of the base e.g. crystal frequency adjustment at address 0000 and 0001, some are set by the user configuration e.g. ringer volume at address 0220, and some are set during normal use of the phone e.g. meter pulse billing at address 0140..015F.

32.2. Introduction

The base unit uses a 128K bit (128 x 8) serial EEPROM (IC9) for storing volatile parameters. All parameters are set up before the base leaves the factory. Some of these are vital for the operation of the hardware so a set of default parameters is programmed before the actual hardware fine-tuning can be initiated. This document lists all default settings with a short description.

In the tables below values in a range that are similar are not repeated; i.e. Address 00 to 01 contains the value 00 simply means that the value 00 is repeated in all addresses in the range. All values in this document are in hexadecimal notation.

Type	Name	Description
D	default	The EEPROM location is preset to the Default value by the eeprom default
A	adjust	The EEPROM location is set during the production test and should not be overwritten. The value is set by the eeprom default loader only if the locati contains all 1's (byte: 0xFF, word FFFFh), i, e. it has never been set.
-		EEPROM location which is not set at all.
d	default	Same as D but best-guess value and/or not verified.

Country Setting	x	Default - no specific country setting, so revert to default value
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32.3. EEPROM Layout

32.3.1. General Setup

Address	Default	Name	Country Setting	Type	Description
0000-01	00 E0	EepromOscillator	x	A	Frequency adjustment
0002	20	ModulationDeviation	x	A	Modulation adjustment
0020	-	RFPI (ID for Base Unit)	x	A	RFPI
0025	00 00	AC (Base PIN code)	x	D	AC code
0028	00	TBR22Test	x	-	TBR22 test
0030-0034	FF .. FF	IPUI_1	x	D	Ipui for handset 1. If set to FF . handset is not enrolled.
0035-0039	FF .. FF	IPUI_2	x	D	Ipui for handset 2. If set to FF . handset is not enrolled.
003A-003E	FF .. FF	IPUI_3	x	D	Ipui for handset 3. If set to FF . handset is not enrolled.
003F-0043	FF .. FF	IPUI_4	x	D	Ipui for handset 4. If set to FF . handset is not enrolled.
0044-0048	FF .. FF	IPUI_5	x	D	Ipui for handset 5. If set to FF . handset is not enrolled.
0049-004D	FF .. FF	IPUI_6	x	D	Ipui for handset 6. If set to FF . handset is not enrolled.
004E-008F	-	Reserved	x	-	Protocol data
0090-009F	-	UAK_1	x	-	UAK for handset 1
00A0-00AF	-	UAK_2	x	-	UAK for handset 2
00B0-00BF	-	UAK_3	x	-	UAK for handset 3
00C0-00CF	-	UAK_4	x	-	UAK for handset 4
00D0-00DF	-	UAK_5	x	-	UAK for handset 5
00E0-00EF	-	UAK_6	x	-	UAK for handset 6

32.3.2. Switch Control

Address	Default	Name	Country Setting	Type	Description
09F1	00	HsRegInfo.RegFlags	x	D	Handset registration info - registra Bit 6..7: not used 0..5: handset 1..6 info, 1=reg, 0=nc
09F2	00	HsRegInfo.EmcFlags	x	D	Handset registration info - EMC fla Bit 6..7: not used 0..5: handset 1..6 info, 1=known , (unknown
09F3	21	RingMode	x	D	Ring mode. Modes used in KAMM. 20h and 21h. Bit 7..5: Mode (001=group) 4 : Not used 3..0: Id (001= id of first group)

32.3.3. BsUiTask settings

Address	Default	Name	Country Setting	Type	Description
0F4B	RFPI_1	Config1	01	D	BsUiTask configuration (MSB) Bits 1=enable 0=disable 0: AmPmClockSettingEnabled, 1: ClipDetectionSettingEnabled 2: AkzMenuEnabled, disabled 3: HakzMenuEnabled, disabled 4: RussianClipSttingEnabled, d 5: SmscSendNumberSettingEn disabled 6: SMSPabxSupportSettingEna disabled 7: Unused

Address	Default	Name	Country Setting	Type	Description
0F4C	F7	Config2	D7	D	BsUiTask configuration (LSB) Bits 1=enable 0=disable 0: FlashTime1Enabled, enabled 1: FlashTime2Enabled, enabled 2: FlashTime3Enabled, enabled 3: KeyClicksEnable, disabled 4: ARSCarrierMenuEnabled, en 5: ARSIntDeletionMenuEnablec 6: ARSMultipleCarrierMenuEna enabled 7: ARSMultipleAreaCodeMenuE enabled
0F4D	00	UserData.SmsPabxSupport	x	D	SMS PABX Support On/Off

33. EEPROM LAYOUT (HANDSET)

33.1. Scope

The purpose of this section is to describe “layout of the EEPROM (IC2) KX-A140 Handset”. The EEPROM contains hardware, software, and user specific parameters. Some parameters are set during production of the handset e.g. crystal oscillator adjustment at 0000..01, some are set by the user when configuring the handset e.g. ringer volume at 0F38, and some during normal use of the phone e.g. redial memory at 0311..0392.

33.2. Introduction

The handset uses a 32k bit serial EEPROM (IC2) for storing volatile parameters. All parameters are set up before the handset the factory. Some of these are vital for the operation of the hardware so a set of default parameters is programmed before the actual hardware fine-tuning can be initiated. This document lists all default settings with a short description.

This document lists all default parameters with a short description.

In the tables below values in a range that are similar are not repeated; i.e. Address 00 to 01 contains the value 00 simply means that the value 00 is repeated in all addressee in the range.

Type	Name	Description
D	default	The EEPROM location is preset to the Default value by the eeprom default loader.
A	adjust	The EEPROM location is set during the production test and should not be overwritten. The value is set by the eeprom default loader only if the location contains 0xFF, i.e. it has never been set.
-		EEPROM location which is not set at all.

33.3. EEPROM contents

33.3.1. General Setup

Address	Default	Name	Type	Description
0000-0001	00	EepromOscillator	A	Frequency adjustment
0002	20	ModulationDeviation	A	Mudulation adjustment
0030-0034	00	IPEI (ID for Handset)	A	IEPI
0036-003A	FF	PARK_1	-	PARK for registration 1
003B-003F	FF	PARK_2	-	PARK for registration 2
0040-0044	FF	PARK_3	-	PARK for registration 3
0045-0049	FF	PARK_4	-	PARK for registration 4
004A-004D	FF	PLI_1-PLI_4	D	Pli for registration 1-4. If set to FF registration is deleted.

33.3.2. Signal detection

Address	Default	Name	Country Setting	Type	Description
0100-0104	-	RFPI_1	-	-	RFPI for registration 1
0105	-	SerClass_1	-	-	Service class for registration 1
0106	-	LAL_1	-	-	Location area level for registration
0107	-	IPUI_LEN_1	-	-	IPUI length for registration 1
0108-0114	-	IPUI_1	-	-	IPUI for registration 1
0115	-	ZAP_1	-	-	ZAP for registration 1
0116	-	STATUS_1	-	-	Status for registration 1
0117-126	-	UAK_1	-	-	UAK for registration 1
0130-134	-	RFPI_2	-	-	RFPI for registration 2
0135	-	SerClass_2	-	-	Service class for registration 2
0136	-	LAL_2	-	-	Location area level for registration
0137	-	IPUI_LEN_2	-	-	IPUI length for registration 2
0138-0144	-	IPUI_2	-	-	IPUI for registration 2
0145	-	ZAP_2	-	-	ZAP for registration 2
0146	-	STATUS_2	-	-	Status for registration 2
0147-0156	-	UAK_2	-	-	UAK for registration 2
0160-0164	-	RFPI_3	-	-	RFPI for registration 3
0165	-	SerClass_3	-	-	Service class for registration 3
0166	-	LAL_3	-	-	Location area level for registration
0167	-	IPUI_LEN_3	-	-	IPUI length for registration 3
0168-0174	-	IPUI_3	-	-	IPUI for registration 3
0175	-	ZAP_3	-	-	ZAP for registration 3
0176	-	STATUS_3	-	-	status for registration 3
0177-0186	-	UAK_3	-	-	UAK for registration 3

Address	Default	Name	Country Setting	Type	Description
0190-0194	-	RFPI_4	-	-	RFPI for registration 4
0195	-	SerClass_4	-	-	Service class for registration 4
0196	-	LAL_4	-	-	Location area level for registration 4
0197	-	IPUI_LEN_4	-	-	IPUI length for registration 4
0198-01A4	-	IPUI_4	-	-	IPUI for registration 4
01A5	-	ZAP_4	-	-	ZAP for registration 4
01A6	-	STATUS_4	-	-	UAK for registration 4
01A7-01B6	-	UAK_4	-	-	UAK for registration 4
0450-0451	-	HSPinCode	-	-	4 BCD Digits
0462	00	Language	0A	D	00 = English 01 = Spanish 02 = French 03 = Italian 04 = Dutch 05 = Turkish 06 = Hungarian 07 = Portuguese 08 = Polish 09 = Command 0A = German
0467	00	FactoryLanguageSetting	0A	D	Factory setting for language: 00 = English 01 = Spanish 02 = French 03 = Italian 04 = Dutch 05 = Turkish 06 = Hungarian 07 = Portuguese 08 = Polish 09 = Command 0A = German

33.3.3. Battery Parameters

Address	Default	Name	Type	Description
0F04	9A	LowVoltage	A	Voltage on which to start battery low indication. The voltage has to be measured within a value for 8 seconds before the handset starts signaling low battery. LowVoltage[EEPROM]=[ADC-steps] LowVoltage[mV]=(14.35[mV/step])

33.3.4. Default Audio-Parameters

Address	Default	Name	Type	Description
0F37	5F	GR-offset for volume step 2	A	Bit7: AOG Bit6: AOG2 Bit5: ? bit0: Gain-receive (values ranging from 0x00 to 0x30 step representing 1 dB)

33.3.5. VolumeSetting Second Block

Address	Default	Name	Country Setting	Type	Description
0F53	FF	MenuConfig	20	D	bit 0 - Registration menu bit 1 - Select base menu code bit 2 - Internal ringtone menu code 0 bit 3 - Page ringtone menu code bit 4 - Standby mode menu code /0 bit 5 - Battery select menu code 0 bit 6 - Call waiting menu code bit 7 - Clip list on/off 1/0

34. SCHEMATIC DIAGRAM (BASE UNIT)

35. SCHEMATIC DIAGRAM (HANDSET)

36. CIRCUIT BOARD (BASE UNIT)

36.1. Component View

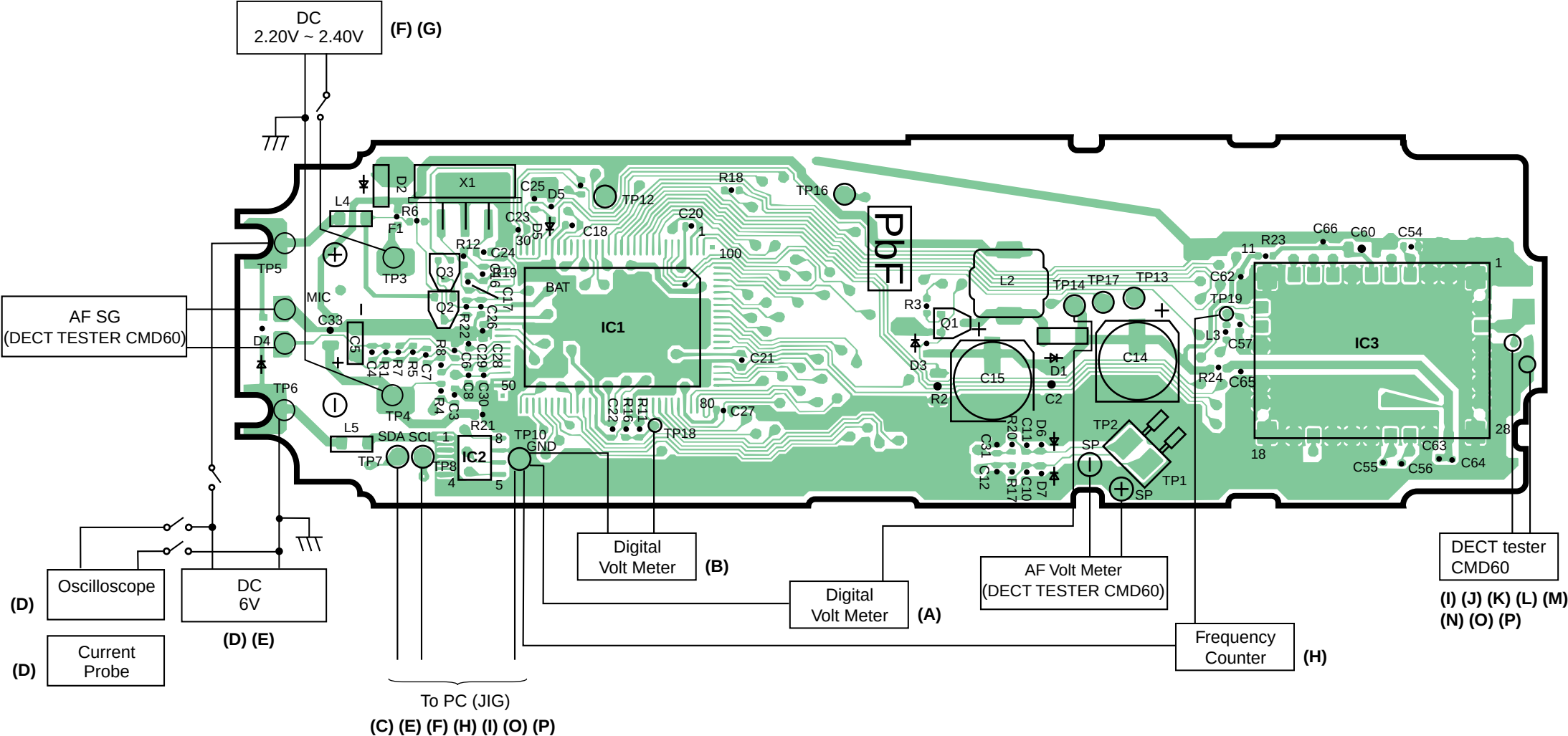
36.2. Flow Solder Side View

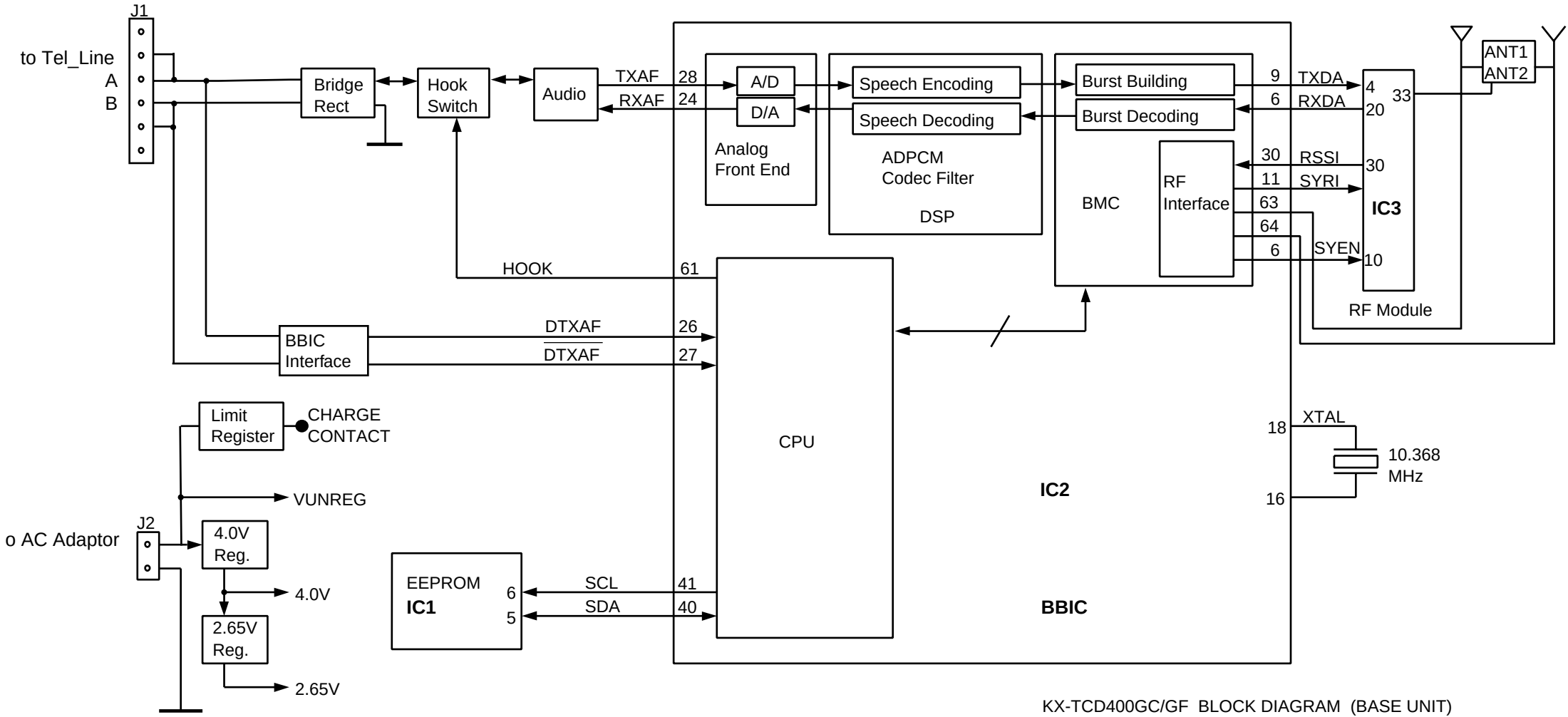
37. CIRCUIT BOARD (HANDSET)

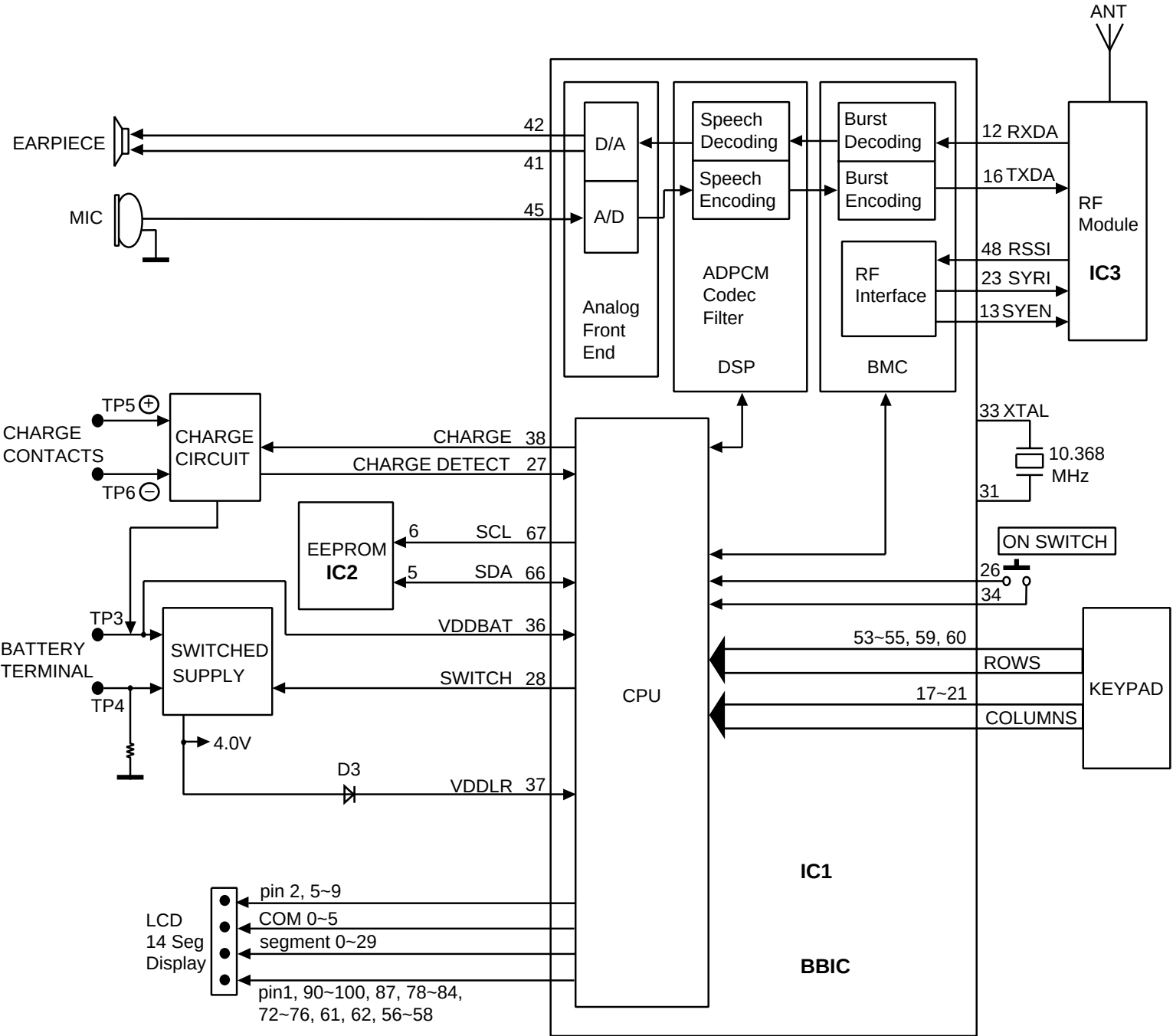
37.1. Component View

37.2. Flow Solder Side View

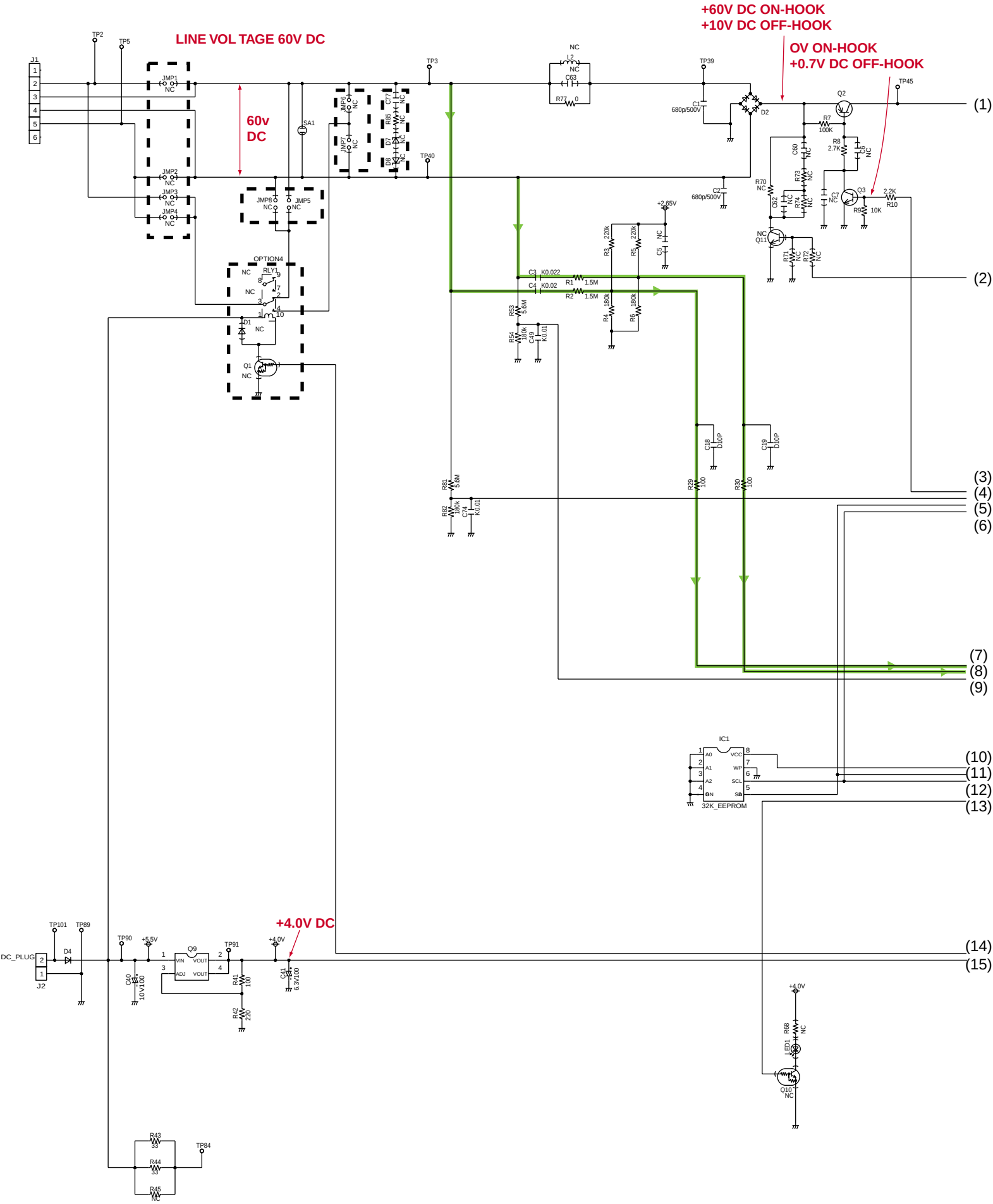
M / KXTCD400GC / KXTCD400GF / KXA140EXC / KXA140EXF

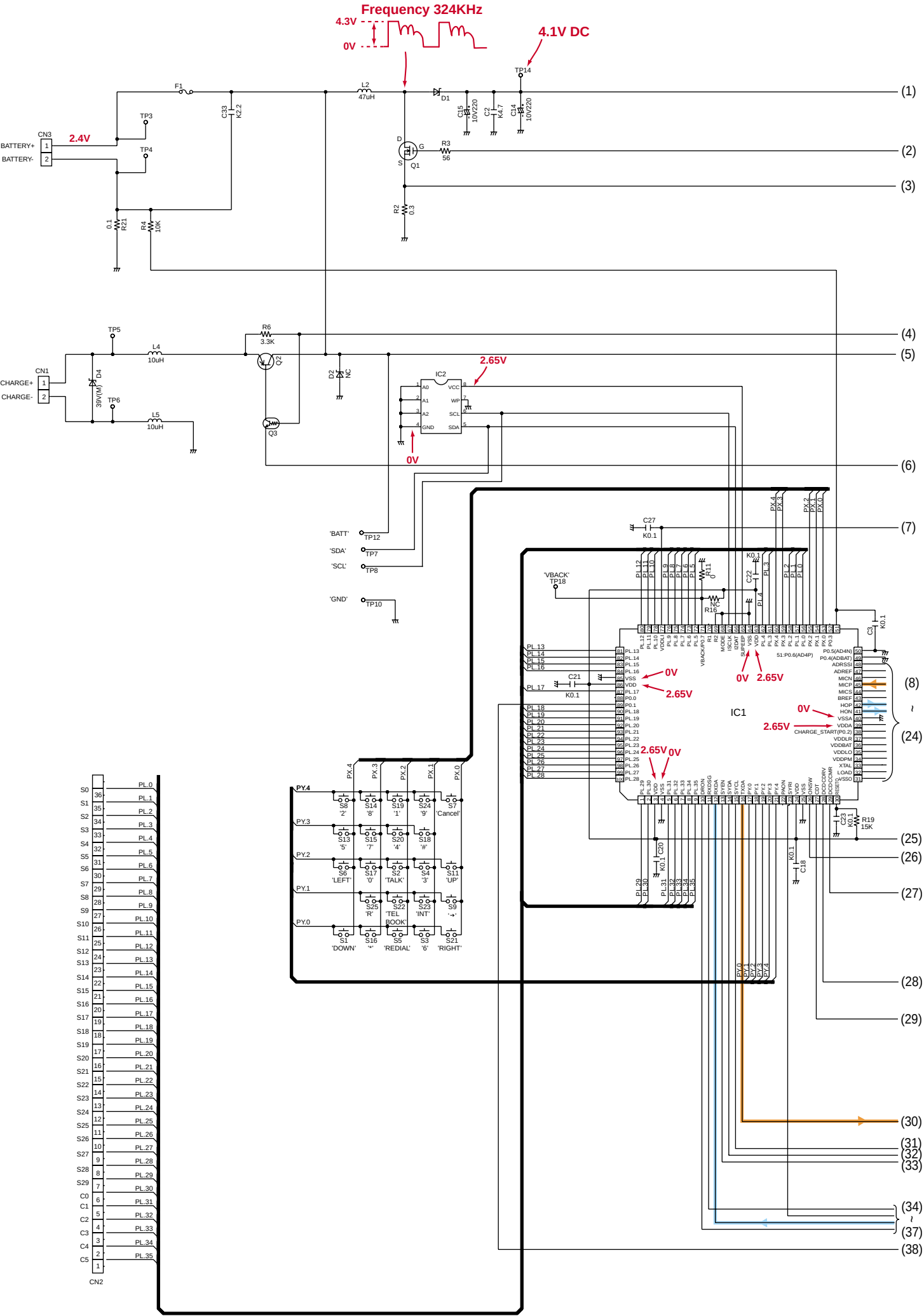


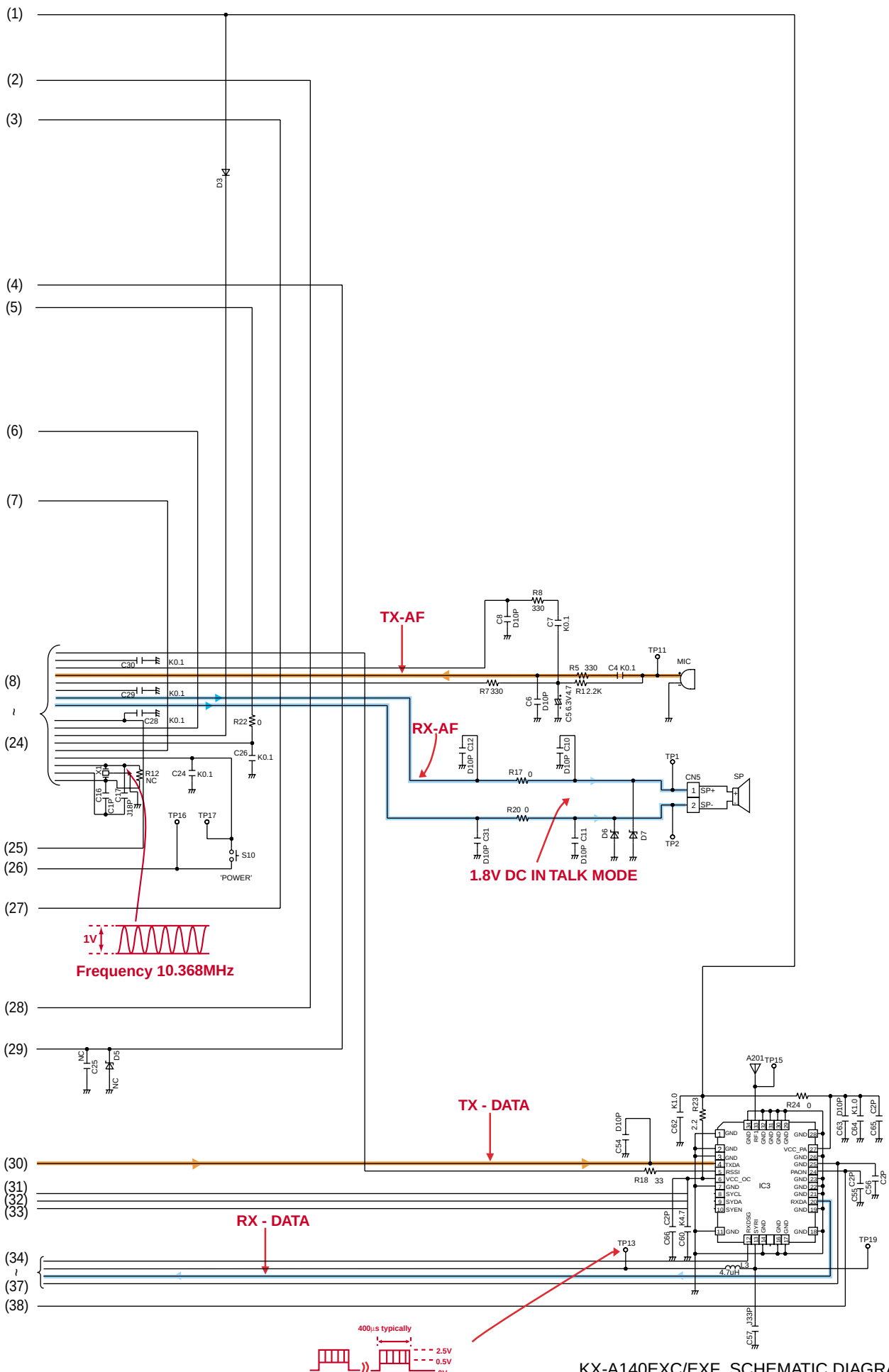




KX-A140EXC/EXF BLOCK DIAGRAM (HANDSET)

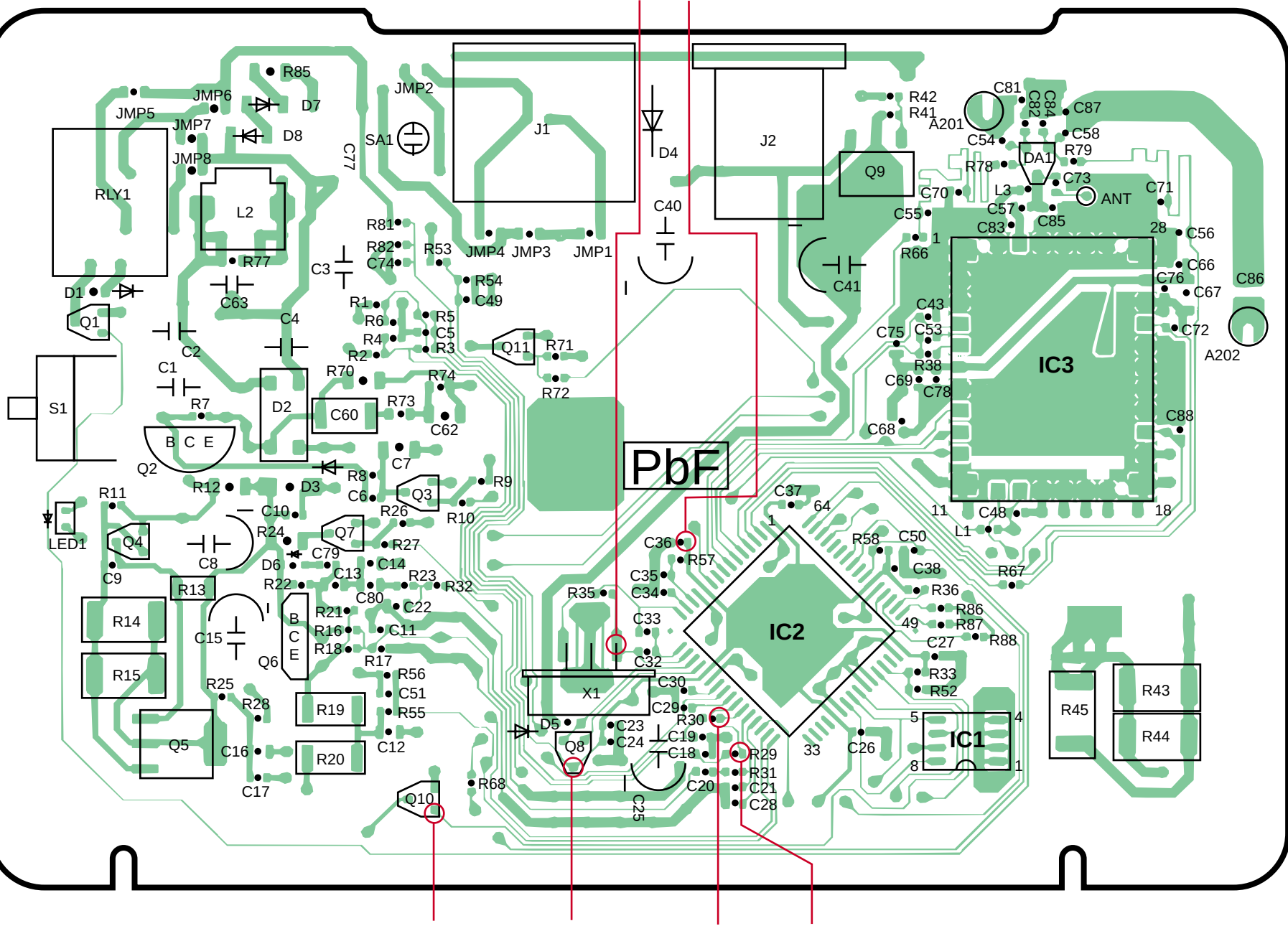






KX-A140EXC/EXF SCHEMATIC DIAGRAM (HANDSET)

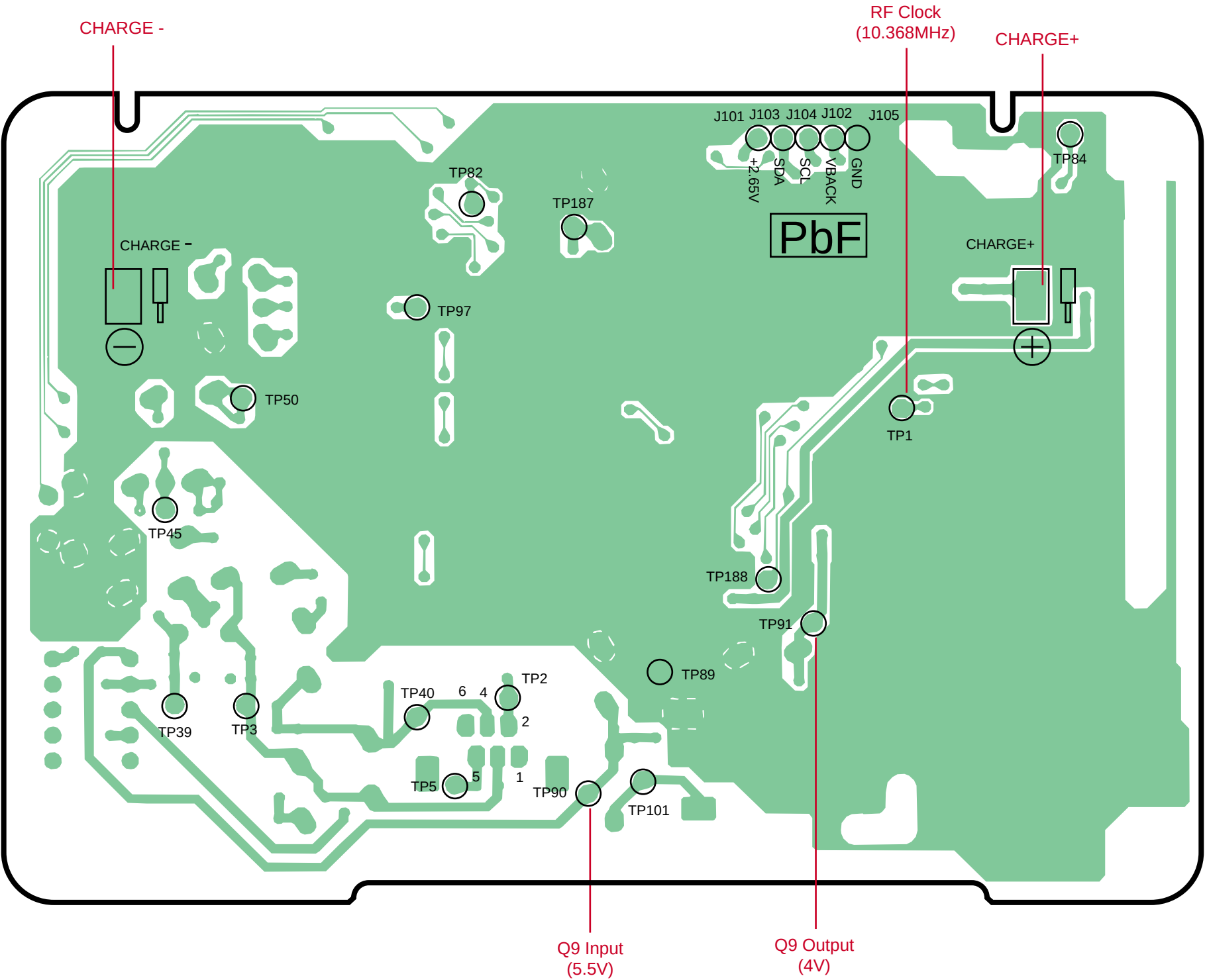
X1
(BBIC: 44
10.368 MHz)
RESET
(BBIC: 14)



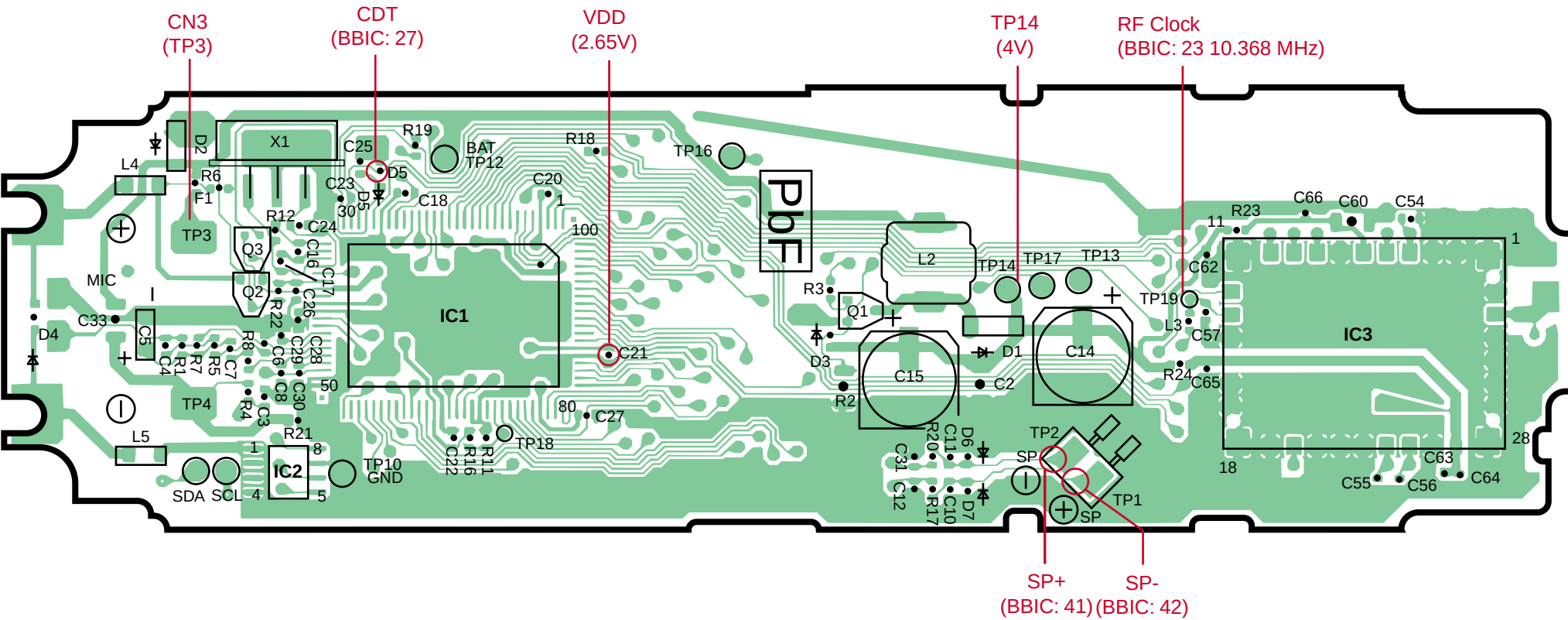
Bell LED
(BBIC: 44)

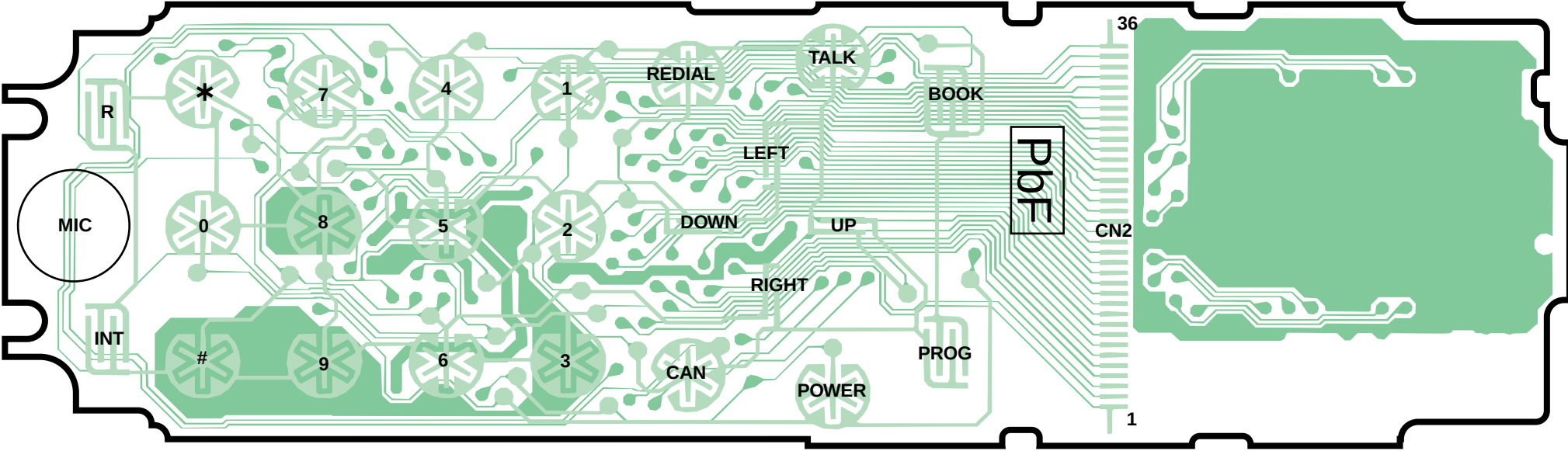
Q8 Collector
(2.65V)

Bell
(BBIC: 27) (BBIC: 26)



KX-TC400GC/GF CIRCUIT BOARD (BASE UNIT) Flow Solder Side View





KX-A140EXC/EXF CIRCUIT BOARD (HANDSET) Flow Solder Side View

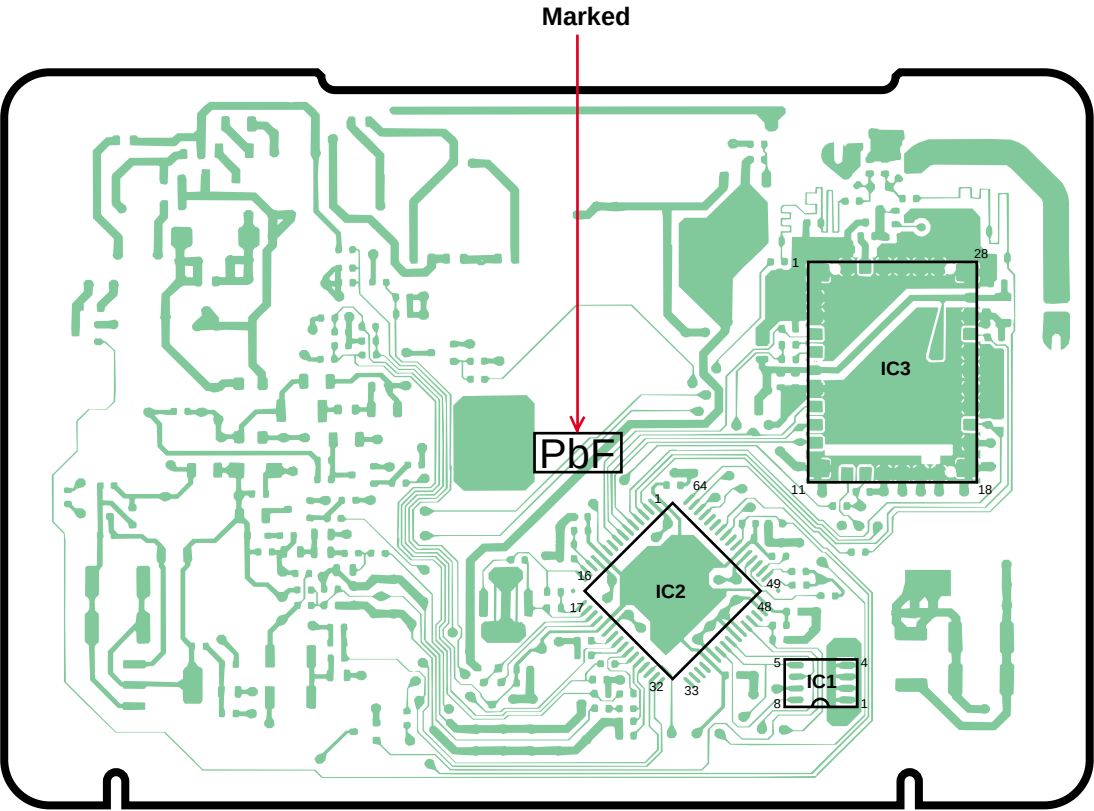
Marked

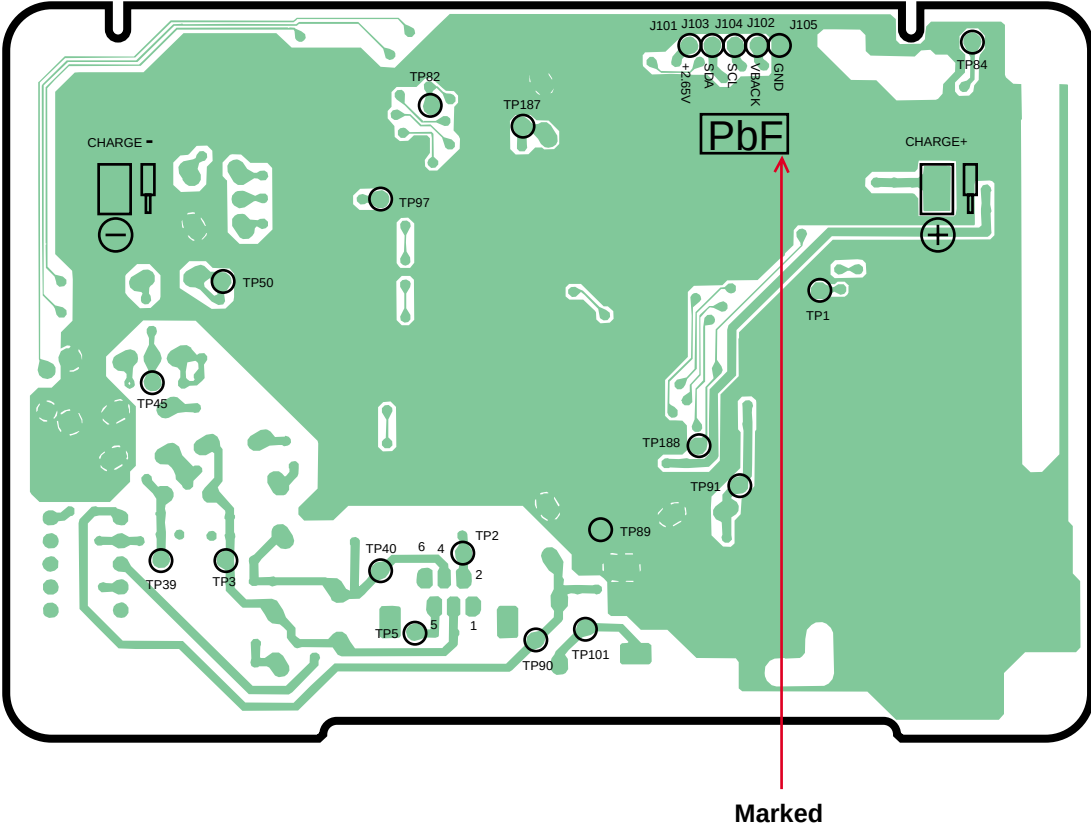
PbF

IC3

IC2

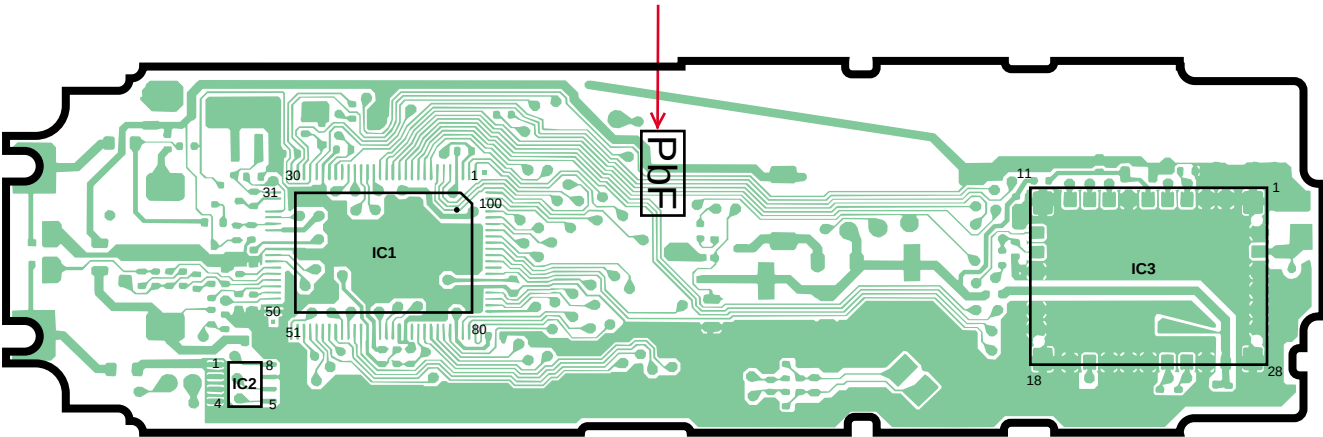
IC1

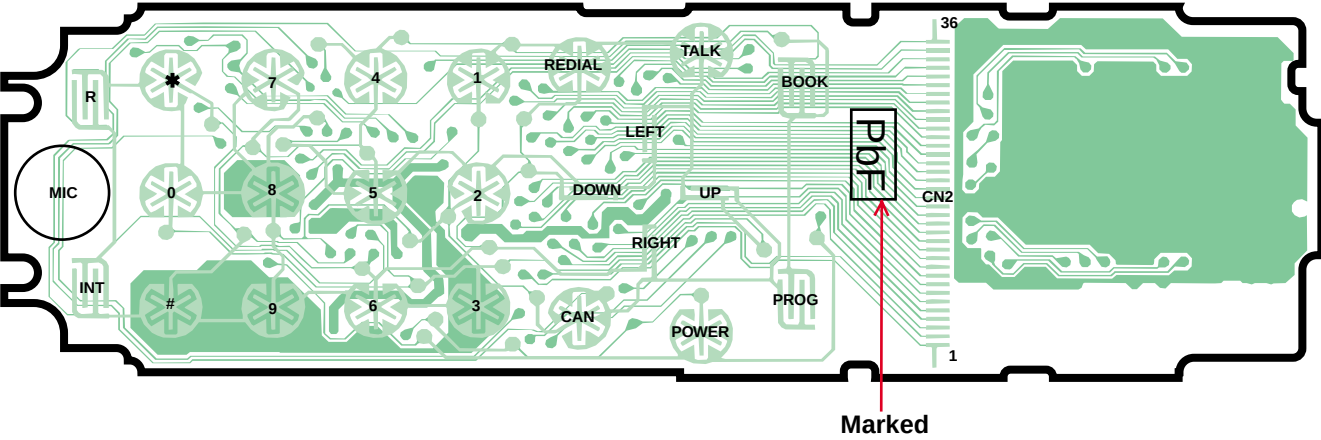




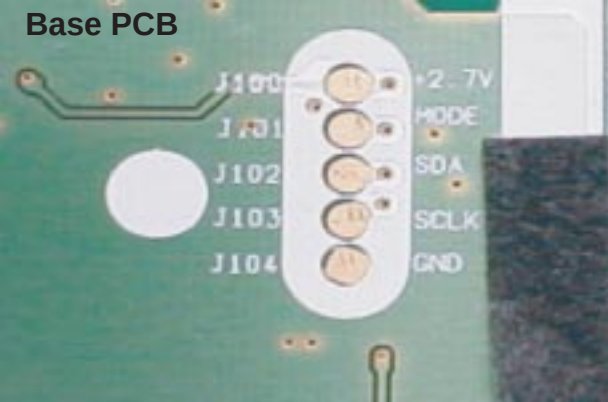
Marked

Marked





Base PCB



Clip

Microsoft Windows 2000 [Version 5.00.2195]
(C) Copyright 1985-2000 Microsoft Corp.

C:¥>cd dect

C:¥DECT>SET RTX_COM=1

C:¥DECT>DOSKEY

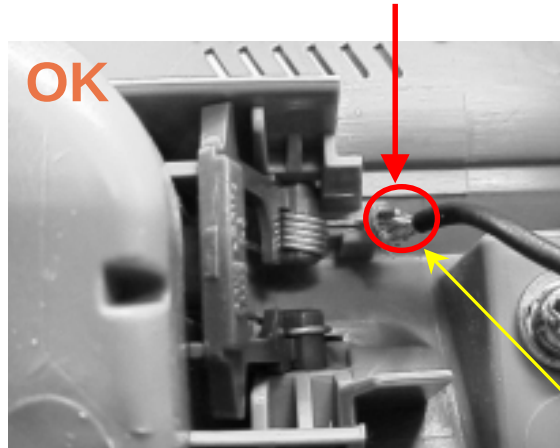
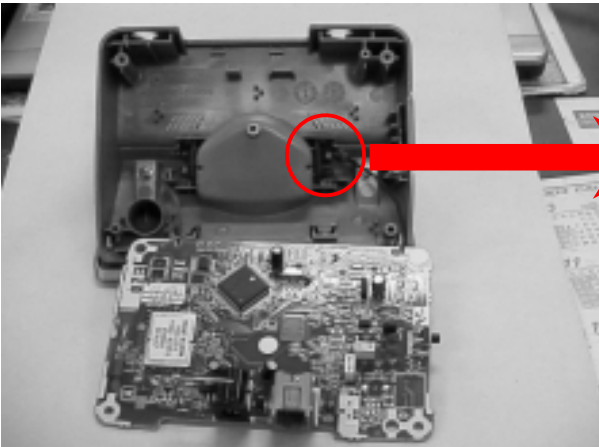
C:¥DECT>initbspin

C:¥DECT>call wreeprom.bat 00 25 00

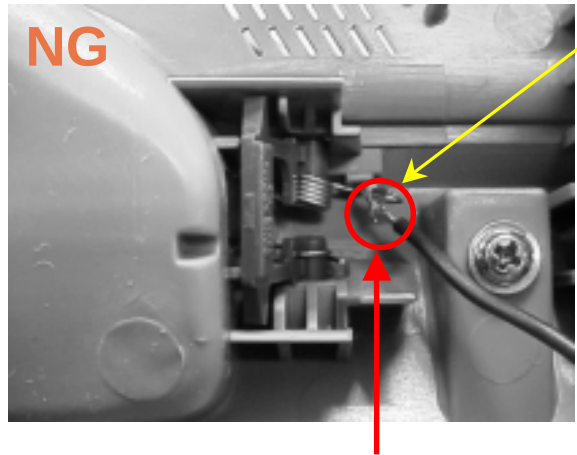
C:¥DECT>call wreeprom.bat 00 26 00

C:¥DECT>_

CHG terminal is properly fit in the cabine



Rib



CHG terminal comes out of rib by pulling black lead wire when opening the cabinet and turning the PCB over. The terminal cannot have enough elastic force, cannot have good contact with handset, and it will result in charge problem.

DECT tester
CMD60

(H) (I) (J) (K) (L)
(M) (N) (O)

To Tel Simulator

